

Intel® Desktop Board D101GGC Product Guide

Order Number: D34588-004

Revision History

Revision	Revision History	Date
-001	First release of the Intel® Desktop Board D101GGC Product Guide	October 2005
-002	Second release of the Intel Desktop Board D101GGC Product Guide	November 2005
-003	Third release of the Intel Desktop Board D101GGC Product Guide	April 2006
-004	Fourth release of the Intel Desktop Board D101GGC Product Guide	July 2006

If an FCC declaration of conformity marking is present on the board, the following statement applies:

FCC Declaration of Conformity

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

For questions related to the EMC performance of this product, contact:

Intel Corporation, 5200 N.E. Elam Young Parkway, Hillsboro, OR 97124
1-800-628-8686

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and the receiver.
- Connect the equipment to an outlet on a circuit other than the one to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

Any changes or modifications to the equipment not expressly approved by Intel Corporation could void the user's authority to operate the equipment.

Tested to comply with FCC standards for home or office use.

Canadian Department of Communications Compliance Statement

This digital apparatus does not exceed the Class B limits for radio noise emissions from digital apparatus set out in the Radio Interference Regulations of the Canadian Department of Communications.

Le présent appareil numérique n'émet pas de bruits radioélectriques dépassant les limites applicables aux appareils numériques de la classe B prescrites dans le Règlement sur le brouillage radioélectrique édicté par le ministère des Communications du Canada.

Disclaimer

Information in this document is provided in connection with Intel® products. No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Intel's Terms and Conditions of Sale for such products, Intel assumes no liability whatsoever, and Intel disclaims any express or implied warranty, relating to sale and/or use of Intel products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. Intel products are not intended for use in medical, life saving, or life sustaining applications. Intel may make changes to specifications and product descriptions at any time, without notice.

Desktop Board D101GGC may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Contact your local Intel sales office or your distributor to obtain the latest specifications and before placing your product order.

Copies of documents which have an ordering number and are referenced in this document, or other Intel literature, may be obtained from Intel Corporation by going to the World Wide Web site at: <http://www.intel.com/> or by calling 1-800-548-4725.

Intel, Pentium, and Celeron are registered trademarks of Intel Corporation or its subsidiaries in the United States and other countries.

* Other names and brands may be claimed as the property of others.

Copyright © 2005-2006, Intel Corporation. All rights reserved.

Preface

This Product Guide gives information about board layout, component installation, and regulatory requirements for Intel® Desktop Board D101GGC.

Intended Audience

The Product Guide is intended for technically qualified personnel. It is not intended for general audiences.

Intended Uses

All Intel desktop boards are evaluated as Information Technology Equipment (I.T.E.) for use in personal computers (PC) for installation in homes, offices, schools, computer rooms, and similar locations. The suitability of this product for other PC or embedded non-PC applications or other environments, such as medical, industrial, alarm systems, test equipment, etc. may not be supported without further evaluation by Intel.

Information Layout

The chapters in this Product Guide are arranged as follows:

[1 Desktop Board Features](#): a summary of product features

[2 Installing and Replacing Desktop Board Components](#): instructions on how to install the desktop board and other hardware components

[ARegulatory Compliance](#): safety and EMC regulations, product certification

Conventions

The following conventions are used in this manual:



CAUTION

Cautions warn the user about how to prevent damage to hardware or loss of data.



NOTE

Notes call attention to important information.

Terminology

The table below gives descriptions to some common terms used in the product guide.

Term	Description
GB	Gigabyte (1,073,741,824 bytes)
GHz	Gigahertz (one billion hertz)
KB	Kilobyte (1024 bytes)
MB	Megabyte (1,048,576 bytes)
Mbit	Megabit (1,048,576 bits)
MHz	Megahertz (one million hertz)

Box Contents

- Intel Desktop Board
- I/O shield
- One ATA-66/100 cable
- One Serial ATA cable
- One diskette drive cable
- Quick Reference poster
- Configuration and battery caution statement label
- Intel® Express Installer driver CD-ROM

Contents

1 Desktop Board Features

Supported Operating Systems	10
Desktop Board Components	11
Processor.....	13
Main Memory	13
ATI RADEON* XPRESS 200 Chipset.....	14
Graphics Subsystem	14
Audio Subsystem	14
Input/Output (I/O) Controller	15
LAN Subsystem	15
LAN Subsystem Software.....	15
RJ-45 LAN Connector LEDs.....	15
Hi-Speed USB 2.0 Support.....	16
Enhanced IDE Interface	17
Serial ATA.....	17
Expandability.....	17
BIOS	17
Serial ATA and IDE Auto Configuration	17
PCI and PCI Express Auto Configuration	17
Security Passwords	18
Chassis Intrusion.....	18
Power Management Features	18
ACPI.....	18
Power Connectors.....	18
Fan Connectors.....	19
Suspend to RAM (Instantly Available PC Technology)	19
Wake from USB.....	20
Wake from PS/2 Keyboard/Mouse.....	20
PME# Wakeup Support.....	20
Speaker.....	21
Battery.....	21
Real-Time Clock.....	21

2 Installing and Replacing Desktop Board Components

Before You Begin	23
Installation Precautions	24
Prevent Power Supply Overload.....	24
Observe Safety and Regulatory Requirements.....	24
Installing the I/O Shield	25
Installing and Removing the Desktop Board.....	26
Installing and Removing a Processor	27
Installing a Processor	27
Installing the Processor Fan Heat Sink.....	30
Connecting the Processor Fan Heat Sink Cable.....	30
Removing the Processor	30

Installing and Removing Memory	31
Installing DIMMs	31
Removing DIMMs	33
Installing and Removing a PCI Express* x16 Card	34
Installing a PCI Express x16 Card	34
Removing the PCI Express x16 Card	34
Connecting the IDE Cable	35
Connecting the Serial ATA (SATA) Cable	36
Connecting Internal Headers	37
Installing a Front Panel Audio Solution for High Definition Audio	38
Connecting Hi-Speed USB 2.0 Headers	39
Connecting the Front Panel Header	39
Setting Up the Flexible 6-Channel Audio with Jack Re-tasking (Optional)	40
Connecting Fan and Power Cables	41
Connecting Fan Cables	41
Connecting Power Cables	42
Other Connectors	43
Setting the BIOS Configuration Jumper	44
Clearing Passwords	45

A Regulatory Compliance

Safety Regulations	51
Place Battery Marking	51
European Union Declaration of Conformity Statement	52
Product Ecology Statements	53
Lead-Free Desktop Board	55
EMC Regulations	56
Ensure System EMC Compliance	57
Product Certifications	58
Board-Level Certification Markings	58
Chassis and Component Certifications	59

Figures

1. Intel Desktop Board D101GGC Components	11
2. LAN Connector LEDs	16
3. Location of the Standby Power Indicator	20
4. Installing the I/O Shield	25
5. Desktop Board D101GGC Mounting Screw Hole Locations	26
6. Lift Socket Lever	27
7. Lift the Load Plate and Don't Touch the Socket Contacts	27
8. Remove the Protective Socket Cover	28
9. Remove the Processor from the Protective Processor Cover/Do Not Touch	28
10. Install Processor	29
11. Close the Load Plate	29
12. Connecting the Processor Fan Heat Sink Cable to the Processor Fan Connector	30
13. Use DDR DIMMs	31
14. Installing a DIMM	32
15. Removing a PCI Express x16 Card	34
16. Connecting the IDE Cable	35

17. Connecting the Serial ATA Cable	36
18. Internal Headers	37
19. Back Panel Audio Connectors for Flexible 6-Channel Audio System	40
20. Location of Fan Headers.....	41
21. Connecting 2x12 Power Supply Cables	42
22. Location of Other Connectors on Desktop Board D101GGC.....	43
23. Location of the BIOS Configuration Jumper Block	44
24. Removing the Battery	50

Tables

1. Feature Summary	9
2. Desktop Boards D101GGC Components.....	12
3. Power Supply Requirements.....	13
4. RJ-45 10/100 Ethernet LAN Connector LEDs	16
5. Front Panel Audio Header Signal Names for High Definition Audio.....	38
6. AC '97 Audio Header Signal Names	38
7. Hi-Speed USB 2.0 Header Signal Names	39
8. Front Panel Header Signal Names.....	39
9. Jumper Settings for the BIOS Setup Program Modes	45
10. Safety Regulations.....	51
11. Lead-Free Board Markings	55
12. EMC Regulations.....	56
13. Product Certification Markings	58

1 Desktop Board Features

This chapter briefly describes the main features of Intel® Desktop Board D101GGC. Table 1 summarizes the major features of the desktop board.

Table 1. Feature Summary

Form Factor	MicroATX (243.84 millimeters [9.60 inches] x 218.44 millimeters [8.60 inches])
<u>Processor</u>	Support for an Intel® processor in the LGA775 package
<u>Main Memory</u>	<ul style="list-style-type: none">• Two 184-pin, 2.5 V SDRAM Dual Inline Memory Module (DIMM) sockets• 400/333 MHz single channel DDR SDRAM interface• Designed to support up to 2 GB of system memory
<u>Chipset</u>	ATI RADEON* XPRESS 200 <ul style="list-style-type: none">• ATI RADEON XPRESS Northbridge• ATI IXP 450 Southbridge
<u>Graphics</u>	ATI RADEON XPRESS 200 Graphics with support for external graphics via a PCI Express* x16 connector
<u>Audio</u>	<ul style="list-style-type: none">• ATI RADEON XPRESS 200 Chipset• High Definition Audio interface• Realtek* codec
<u>Expansion Capabilities</u>	<ul style="list-style-type: none">• Two PCI bus add-in card connectors• One PCI Express x16 connector• One PCI Express x1 connector
<u>Peripheral Interfaces</u>	<ul style="list-style-type: none">• Eight USB 2.0 ports<ul style="list-style-type: none">— Four ports routed to the back panel— Four ports routed to two USB headers• Four Serial ATA (SATA) channels (1.5 Gb/s)• Two IDE interfaces with ATA-100 support (four devices)• One VGA connector• One diskette drive interface• One parallel port• One serial port• PS/2* keyboard and mouse ports
<u>BIOS</u>	<ul style="list-style-type: none">• AwardBIOS*
<u>Power Management</u>	<ul style="list-style-type: none">• Support for Advanced Configuration and Power Interface (ACPI)• Suspend to RAM (STR)• Wake on USB, PCI, PCI Express, PS/2, LAN, and front panel

Related Links:

For more information about desktop board D101GGC, including the Technical Product Specification (TPS), BIOS updates, and device drivers, go to:

<http://support.intel.com/support/motherboards/desktop/>

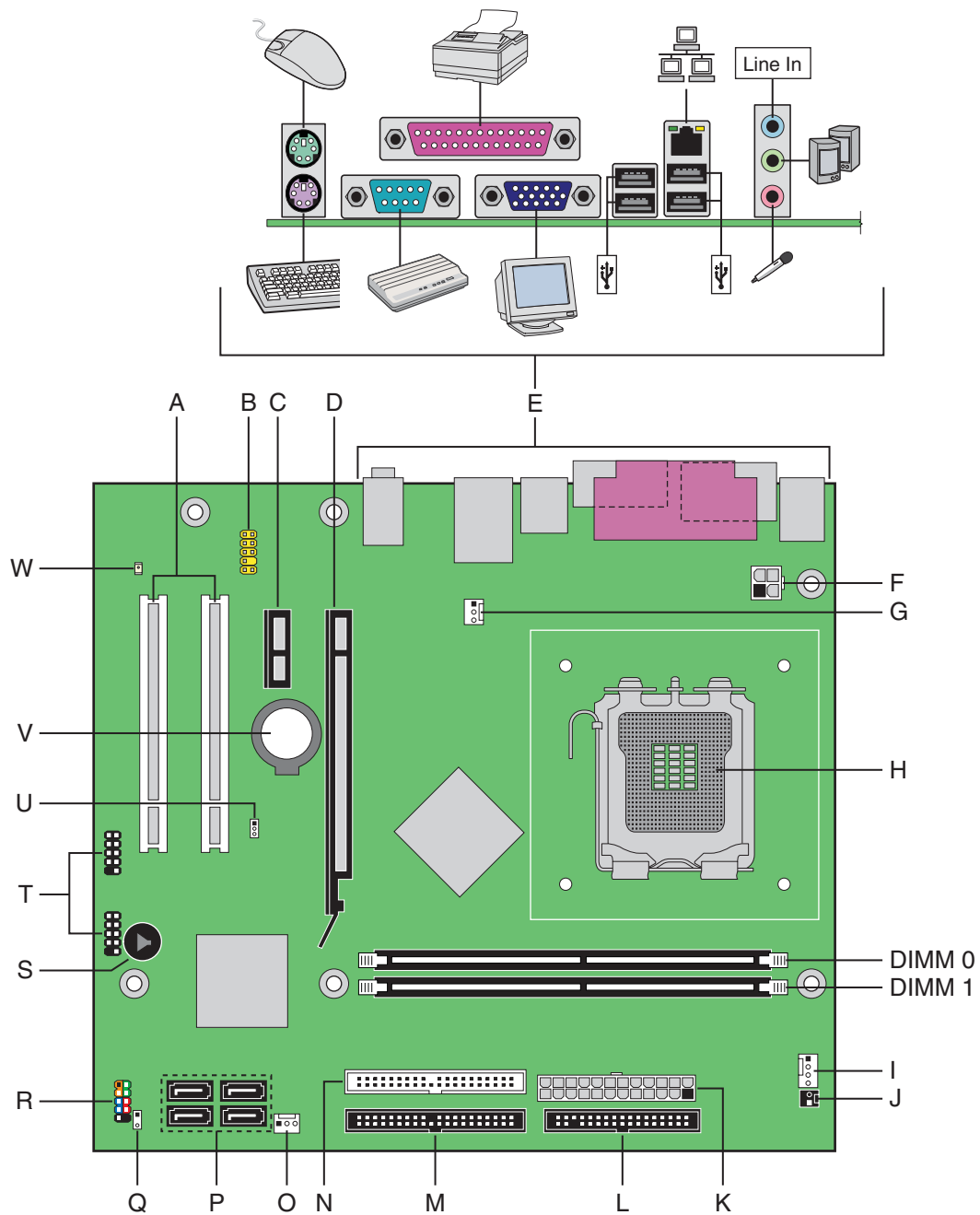
Supported Operating Systems

The desktop board supports the following operating systems:

- Microsoft Windows* XP Media Center Edition 2005
- Microsoft Windows XP Professional
- Microsoft Windows XP Professional x64 Edition
- Microsoft Windows XP Home
- Microsoft Windows 2000

Desktop Board Components

Figure 1 shows the approximate location of the major components on desktop board D101GGC.



OM18207

Figure 1. Intel Desktop Board D101GGC Components

Table 2. Desktop Boards D101GGC Components

Label	Description
A	PCI bus add-in card connectors
B	Front panel audio header
C	PCI Express* x1 connector
D	PCI Express x16 connector
E	Back panel connectors
F	12 V processor core voltage connector (2x2)
G	Rear fan (3-pin)
H	Processor socket
I	Processor fan header (4-pin)
J	Chassis intrusion connector
K	Main power connector (2x12)
L	Diskette drive connector
M	Primary IDE connector
N	Secondary IDE connector
O	Front chassis fan header (3-pin)
P	Serial ATA connectors
Q	Alternate front panel power LED header
R	Front panel header
S	Speaker
T	Hi-speed USB 2.0 headers
U	BIOS configuration jumper
V	Battery
W	Standby LED

Related Links:

Go to the following links for more information about:

- Desktop board D101GGC <http://www.intel.com/design/motherbd>
<http://support.intel.com/support/motherboards/desktop>
- Supported processors <http://support.intel.com/support/motherboards/desktop>
- Audio software and utilities <http://www.intel.com/design/motherbd>
- LAN software and drivers <http://www.intel.com/design/motherbd>

Processor



CAUTION

Failure to use the appropriate power supply (below) and/or not connecting the 12 V (2x2) power connector to the desktop board may result in damage to the board, or the system may not function properly.

Table 3. Power Supply Requirements

Platform Compatibility Guide	Power Supply Requirements
05A	12V2 rating of 13 A continuous and 16.5 A peak current for 10 ms
04A	ATX12V (version 2.0 or greater) compliant power supply

Desktop board D101GGC supports an Intel processor in the LGA775 package. Processors are not included with the desktop board and must be purchased separately. The processor connects to the desktop board through the LGA775 socket.

The supported processors list for desktop board D101GGC is located on the web at:

<http://support.intel.com/support/motherboards/desktop/>

Related Links:

Go to the following links or pages for more information about:

- Instructions on installing or upgrading the processor, page 27 in Chapter 2
- The location of the two power connectors, page 41 in Chapter 2

Main Memory



NOTE

To be fully compliant with all applicable Intel® SDRAM memory specifications, the board should be populated with DIMMs that support the Serial Presence Detect (SPD) data structure. If your memory modules do not support SPD, you will see a notification to this effect on the screen at power up. The BIOS will attempt to configure the memory controller for normal operation.

The desktop board supports the memory configurations defined below:

- Two 184-pin Double Data Rate (DDR) SDRAM Dual Inline Memory Module (DIMMs) connectors with gold-plated contacts
- Unbuffered, non-registered DIMMs
- Serial Presence Detect (SPD) memory only
- Non-ECC DDR
- 2.5 V memory
- Memory configuration listed below:
 - Up to 1.0 GB utilizing 256 Mb technology
 - Up to 2.0 GB utilizing 512 Mb or 1 Gb technology

Related Links:

Go to the following links or pages for more information about:

- The latest list of tested memory, <http://support.intel.com/support/motherboards/desktop/>
- SDRAM specifications, <http://www.intel.com/technology/memory/>
- Installing memory, page 31 in Chapter 2

ATI RADEON* XPRESS 200 Chipset

The ATI RADEON XPRESS 200 Chipset consists of the following devices:

- ATI RADEON XPRESS Northbridge
- ATI IXP 450 Southbridge

Graphics Subsystem

Desktop board D101GGC includes the following:

- ATI RADEON XPRESS 200 Chipset
- PCI Express x16 connector for graphics expansion

Audio Subsystem

Desktop board D101GGC includes a flexible 6-channel audio subsystem based on a High Definition Audio interface:

The audio subsystem features:

- ATI IXP 450 Southbridge
- Realtek ALC861 audio codec
- Impedance sensing capability for jack re-tasking
- S/N (signal-to-noise) ratio: 90 dB
- Microphone input supporting:
 - Stereo microphone
 - Microphone boost

The subsystem includes the following connectors:

- Front panel audio connector, including functionality for:
 - Line out
 - Microphone in
- Back panel audio connectors that are configurable through the drivers of the audio devices:
 - Rear left/right out or Line In
 - Front left/right out or Line Out
 - Center/LFE out or Mic In

Related Links:

Go to the following link or pages for more information about:

- Audio drivers and utilities <http://support.intel.com/support/motherboards/desktop/>
- Installing the front panel audio solution, page 38 in Chapter 2
- The location of audio connectors, Figure 19 on page 40

Input/Output (I/O) Controller

The super I/O controller features the following:

- One serial port
- One parallel port with Extended Capabilities Port (ECP) and Enhanced Parallel Port (EPP) support
- Serial IRQ interface compatible with serialized IRQ support for PCI systems
- PS/2-style mouse and keyboard interfaces
- Interface for one 1.2 MB or 1.44 MB diskette drive
- Intelligent power management, including a programmable wake up event interface
- PCI power management support

LAN Subsystem

The LAN provides the following functions:

- Basic 10/100 Ethernet LAN (Realtek 8101L controller)
- Support for RJ-45 connector with status indicator LEDs
- Programmable transit threshold
- Configurable EEPROM that contains the MAC address

LAN Subsystem Software

For LAN software and drivers, refer to the D101GGC link on Intel's World Wide Web site at:

<http://support.intel.com/support/motherboards/desktop/>

RJ-45 LAN Connector LEDs

Two LEDs are built into the RJ-45 LAN connector located on the back panel (see Figure 2).

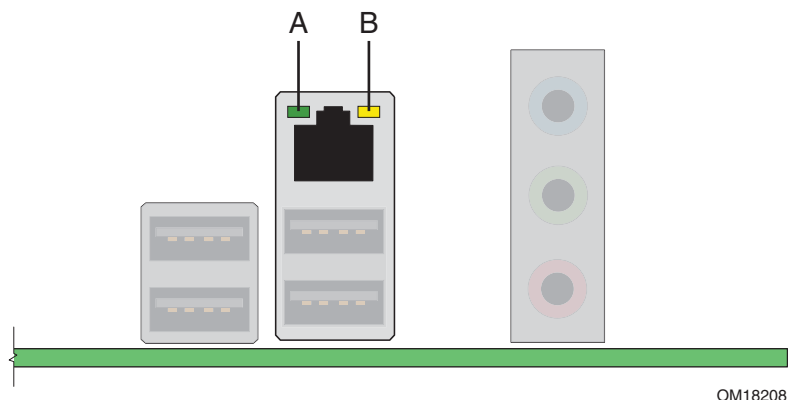


Figure 2. LAN Connector LEDs

Table 4 describes the LED states when the board is powered up and the 10/100 Ethernet LAN subsystem is operating.

Table 4. RJ-45 10/100 Ethernet LAN Connector LEDs

LED	LED State	Indicates
A (Green)	Off	LAN link is not established
	On	LAN link is established
	Blinking	LAN activity is occurring
B (Yellow)	Off	10 Mbits/s data rate is selected
	On (steady state)	100 Mbits/s data rate is selected

Hi-Speed USB 2.0 Support



NOTE

Computer systems that have an unshielded cable attached to a USB port might not meet FCC Class B requirements, even if no device or a low-speed USB device is attached to the cable. Use a shielded cable that meets the requirements for a full-speed USB device.

The desktop board supports up to eight USB 2.0; four ports routed to the back panel and four routed to two internal USB 2.0 headers. USB 2.0 ports are backward compatible with USB 1.1 devices. USB 1.1 devices will function normally at USB 1.1 speeds.

USB 2.0 support requires both an operating system and drivers that fully support USB 2.0 transfer rates. Disabling Hi-Speed USB in the BIOS reverts all USB 2.0 ports to USB 1.1 operation. This may be required to accommodate operating systems that do not support USB 2.0.

Enhanced IDE Interface

The IDE interface handles the exchange of information between the processor and peripheral devices like hard disks, CD-ROM drives, and Iomega Zip* drives inside the computer. The interface supports:

- Up to four IDE devices (such as hard drives)
- ATAPI-style devices (such as CD-ROM drives)
- Older PIO Mode devices
- Ultra DMA-33/66/100 modes

Serial ATA

The desktop board supports four Serial ATA channels (1.5 Gb/s), connecting one device per channel.

Expandability

The desktop board supports the following:

- One PCI Express x16 add-in card
- One PCI Express x1 add-in card
- Two PCI add-in cards

Related Links:

For information about installing the PCI Express x16 card, see page 34 in Chapter 2.

BIOS

The BIOS provides the Power-On Self-Test (POST), the BIOS Setup program, the PCI/PCI Express and IDE auto-configuration utilities, and the video BIOS.

Serial ATA and IDE Auto Configuration

If you install a Serial ATA or IDE device (such as a hard drive) in your computer, the auto-configuration utility in the BIOS automatically detects and configures the device for your computer. You do not need to run the BIOS Setup program after installing a Serial ATA or IDE device. You can override the auto-configuration options by specifying manual configuration in the BIOS Setup program.

PCI and PCI Express Auto Configuration

If you install a PCI/PCI Express add-in card in your computer, the PCI/PCI Express auto-configuration utility in the BIOS automatically detects and configures the resources (IRQs, DMA channels, and I/O space) for that add-in card. You do not need to run the BIOS Setup program after you install a PCI/PCI Express add-in card.

Security Passwords

The BIOS includes security features that restrict whether the BIOS Setup program can be accessed and who can boot the computer. A supervisor password and a user password can be set for the BIOS Setup and for booting the computer, with the following restrictions:

- The supervisor password gives unrestricted access to view and change all Setup options. If only the supervisor password is set, pressing <Enter> at the password prompt of Setup gives the user restricted access to Setup.
- If both the supervisor and user passwords are set, you must enter either the supervisor password or the user password to access Setup. Setup options are then available for viewing and changing depending on whether the supervisor or user password was entered.
- Setting a user password restricts who can boot the computer. The password prompt is displayed before the computer is booted. If only the supervisor password is set, the computer boots without asking for a password. If both passwords are set, you can enter either password to boot the computer.

Related Links:

For instructions on resetting the password, see Clearing Passwords on page 45.

Chassis Intrusion

The board supports a chassis security feature that detects if the chassis cover has been removed. The security feature uses a mechanical switch on the chassis that can be connected to the chassis intrusion connector on the desktop board. See Figure 22 on page 43 for the location of the chassis intrusion connector.

Power Management Features

Power management is implemented at several levels, including:

- Advanced Configuration and Power Interface (ACPI)
- Hardware support:
 - Power connectors
 - Fan connectors
 - Suspend to RAM (Instantly Available PC technology)
 - Wake from USB
 - Wake from PS/2 keyboard/mouse
 - PME# wakeup support

ACPI

ACPI gives the operating system direct control over the power management and Plug and Play functions of a computer. The use of ACPI with the desktop board requires an operating system that provides full ACPI support.

Power Connectors

The desktop board has three power connectors. See Figure 21 on page 42 for the location of the power connectors.

Fan Connectors

The desktop board has a 4-pin processor fan header and two 3-pin chassis fan headers. See Figure 20 on page 41 for the location of the fan headers.

Suspend to RAM (Instantly Available PC Technology)



CAUTIONS

For Instantly Available PC technology, the 5 V standby line for the power supply must be capable of delivering adequate +5 V standby current. Failure to provide adequate standby current when using this feature can damage the power supply and/or effect ACPI S3 sleep state functionality.

Power supplies used with this desktop board must be able to provide enough standby current to support the standard Instantly Available (ACPI S3 sleep state) configuration. If the standby current necessary to support multiple wake events from the PCI and/or USB buses exceeds power supply capacity, the desktop board may lose register settings stored in memory.

Instantly Available PC technology enables the board to enter the ACPI S3 (Suspend-to-RAM) sleep state. While in the S3 sleep state, the computer will appear to be off. When signaled by a wake-up device or event, the system quickly returns to its last known awake state.

The desktop board's standby power indicator, shown in Figure 3, is lit when there is standby power to the system. This includes the memory modules and PCI bus connectors, even when the computer appears to be off.

If the system has a dual-colored power LED on the front panel, the sleep state is indicated by the LED turning amber.

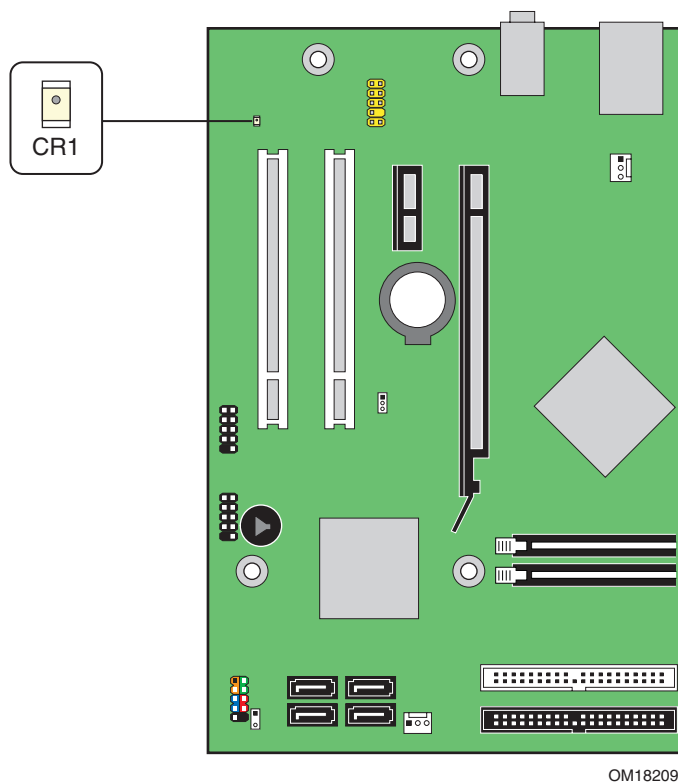


Figure 3. Location of the Standby Power Indicator

Related Links:

For more information on standby current requirements for the desktop board, refer to the Technical Product Specification by going to the following link, finding the product, and selecting Product Documentation from the left-hand menu:

<http://support.intel.com/support/motherboards/desktop/>

Wake from USB



NOTE

Wake from USB requires the use of a USB peripheral that supports wake from USB.

USB bus activity wakes the computer from an ACPI S1 or S3 state.

Wake from PS/2 Keyboard/Mouse

PS/2 keyboard/mouse activity wakes the computer from an ACPI S1 or S3 state.

PME# Wakeup Support

When the PME# signal on the PCI bus is asserted, the computer wakes from an ACPI S1, S3, or S5 state.

Speaker

A speaker is mounted on the desktop board. The speaker provides audible error code (beep code) information during the Power-On Self-Test (POST).

Battery

A battery on the desktop board keeps the values in CMOS RAM and the clock current when the computer is turned off. Go to page 46 for instructions on how to replace the battery.

Real-Time Clock

The desktop board has a time-of-day clock and 100-year calendar. The battery on the desktop board keeps the clock current when the computer is turned off.

2 Installing and Replacing Desktop Board Components

This chapter tells you how to:

- Install the I/O shield
- Install and remove the desktop board
- Install and remove a processor and memory
- Install and remove a PCI Express x16 card
- Connect the IDE and Serial ATA cables
- Connect internal headers
- Set up flexible 6-channel audio with jack re-tasking
- Connect fans and power cables
- Locate other connectors
- Set the BIOS configuration jumper
- Clear passwords
- Replace the battery

Before You Begin



CAUTIONS

The procedures in this chapter assume familiarity with the general terminology associated with personal computers and with the safety practices and regulatory compliance required for using and modifying electronic equipment.

Disconnect the computer from its power source and from any telecommunications links, networks, or modems before performing any of the procedures described in this chapter. Failure to disconnect power, telecommunications links, networks, or modems before you open the computer or perform any procedures can result in personal injury or equipment damage. Some circuitry on the board can continue to operate even though the front panel power button is off.

Follow these guidelines before you begin installing the desktop board:

- Always follow the steps in each procedure in the correct order.
- Set up a log to record information about your computer, such as model, serial numbers, installed options, and configuration information.
- Electrostatic discharge (ESD) can damage components. Perform the procedures described in this chapter only at an ESD workstation using an antistatic wrist strap and a conductive foam pad. If such a station is not available, you can provide some ESD protection by wearing an antistatic wrist strap and attaching it to a metal part of the computer chassis.

Installation Precautions

When you install and test the Intel desktop board, observe all warnings and cautions in the installation instructions.

To avoid injury, be careful of:

- Sharp pins on connectors
- Sharp pins on printed circuit assemblies
- Rough edges and sharp corners on the chassis
- Hot components (like processors, voltage regulators, and heat sinks)
- Damage to wires that could cause a short circuit

Observe all warnings and cautions that instruct you to refer computer servicing to qualified technical personnel.

Prevent Power Supply Overload

Do not overload the power supply output. To avoid overloading the power supply, make sure that the calculated total current loads of all the modules within the computer is less than the output current rating of each of the power supplies output circuits.

Observe Safety and Regulatory Requirements

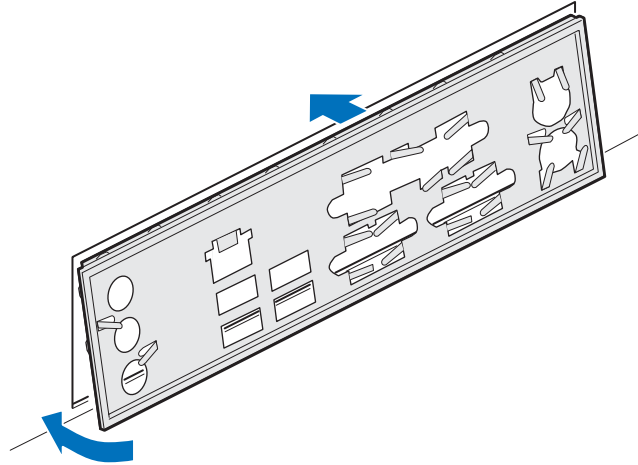
Read and adhere to the instructions in this section and the instructions supplied with the chassis and associated modules. If you do not follow these instructions and the instructions provided by chassis and module suppliers, you increase safety risk and the possibility of noncompliance with regional laws and regulations.

Refer to Appendix A for safety and regulatory requirements.

Installing the I/O Shield

The desktop board comes with an I/O shield. When installed in the chassis, the shield blocks radio frequency transmissions, protects internal components from dust and foreign objects, and promotes correct airflow within the chassis.

Install the I/O shield before installing the desktop board in the chassis. Place the shield inside the chassis as shown in Figure 4. Press the shield into place so that it fits tightly and securely. If the shield doesn't fit, obtain a properly-sized shield from the chassis supplier.



OM18210

Figure 4. Installing the I/O Shield

Installing and Removing the Desktop Board

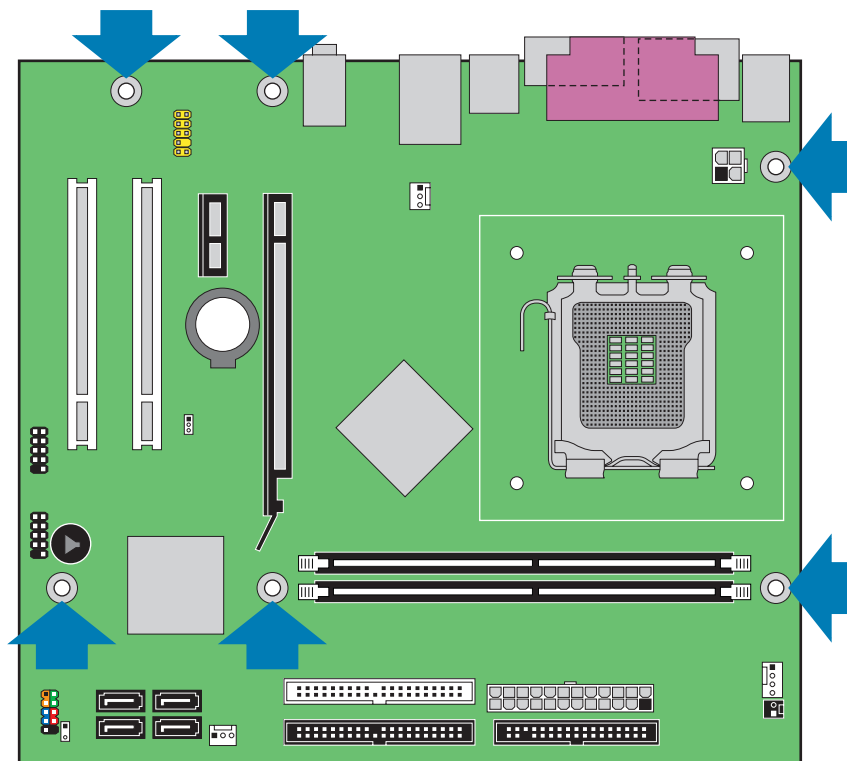


CAUTION

Only qualified technical personnel should do this procedure. Disconnect the computer from its power source before performing the procedures described here. Failure to disconnect the power before you open the computer can result in personal injury or equipment damage.

Refer to your chassis manual for instructions on installing and removing the desktop board.

Figure 5 shows the location of the mounting screw holes for desktop board D101GGC.



OM18211

Figure 5. Desktop Board D101GGC Mounting Screw Hole Locations

Installing and Removing a Processor

Instructions on how to install a processor to the desktop board are given below.

Installing a Processor

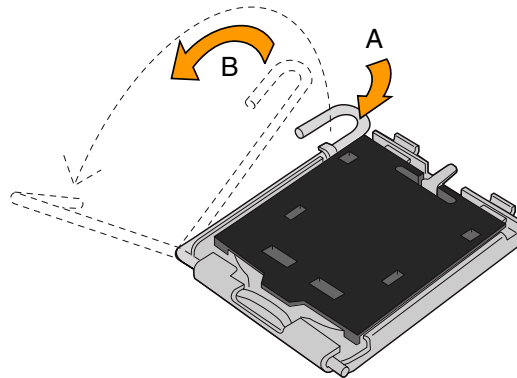


CAUTION

Before installing or removing a processor, make sure the AC power has been removed by unplugging the power cord from the computer; the standby power LED should not be lit (see Figure 3 on page 20). Failure to do so could damage the processor and the board.

To install a processor, follow these instructions:

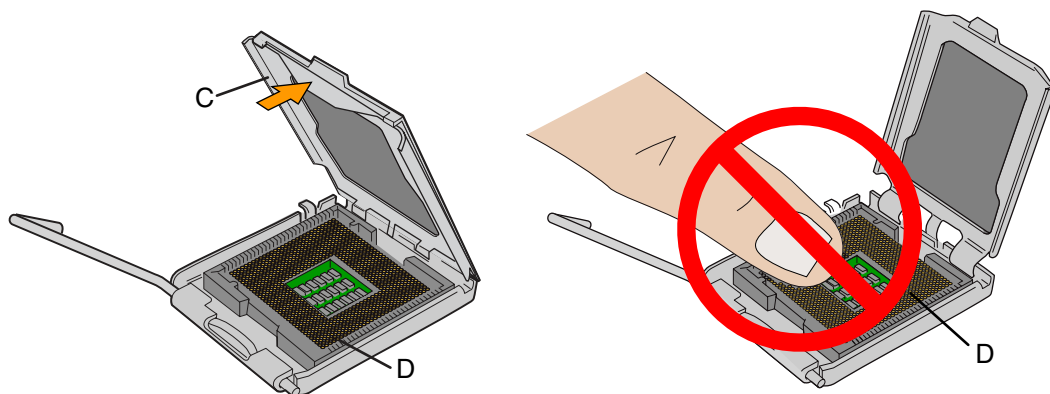
1. Observe the precautions in "Before You Begin" on page 23.
2. Open the socket lever by pushing the lever down and away from the socket (see Figure 6, A and B).



OM17210

Figure 6. Lift Socket Lever

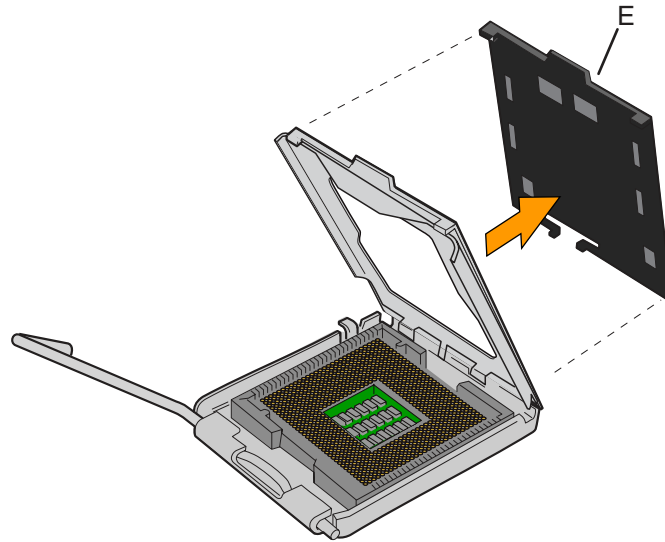
3. Lift the load plate. Do not touch the socket contacts (see Figure 7, C and D)



OM17211

Figure 7. Lift the Load Plate and Don't Touch the Socket Contacts

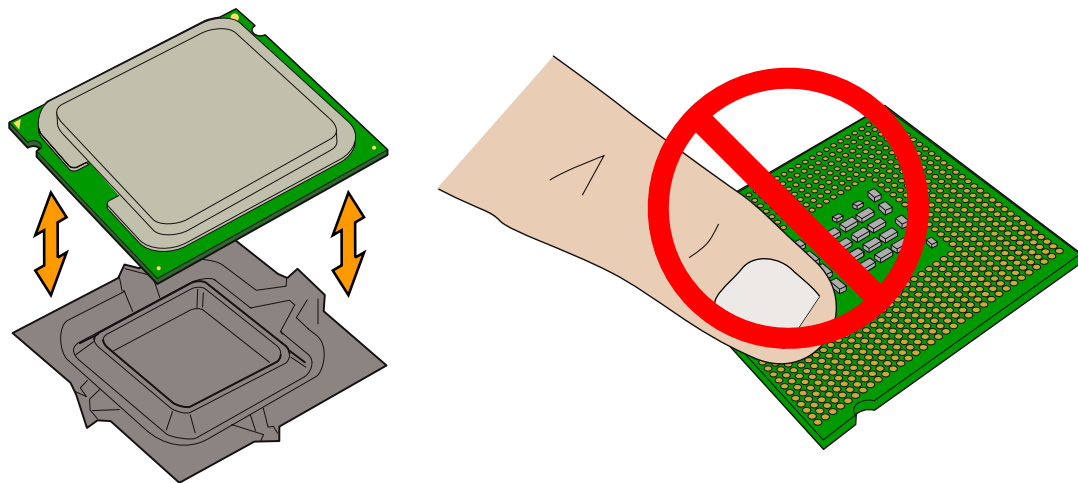
4. Remove the plastic protective socket cover from the load plate (see Figure 8, E). Do not discard the protective socket cover. Always replace the socket cover if the processor is removed from the socket.



OM17228

Figure 8. Remove the Protective Socket Cover

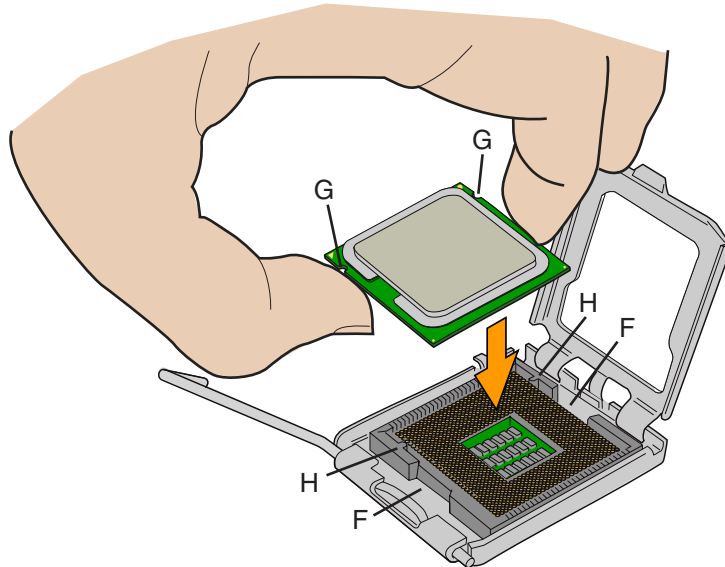
5. Remove the processor from the protective processor cover. Hold the processor only at the edges, being careful not to touch the bottom of the processor (see Figure 9). Do not discard the protective processor cover. Always replace the processor back to the package if the processor is removed from the socket.



OM17213

Figure 9. Remove the Processor from the Protective Processor Cover/Do Not Touch

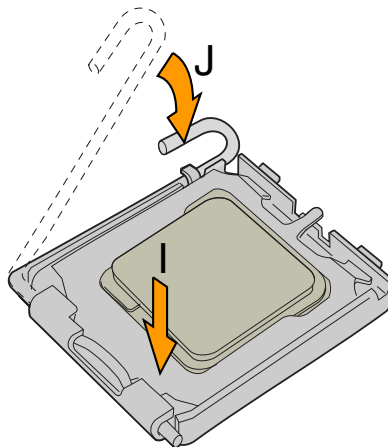
6. Hold the processor with your thumb and index fingers oriented as shown in Figure 10. Make sure fingers align to the socket cutouts (see Figure 10, F). Align notches (see Figure 10, G) with the socket see (Figure 10, H). Lower the processor straight down without tilting or sliding the processor in the socket.



OM17214

Figure 10. Install Processor

7. While pressing down on the load plate (Figure 11, I), close and engage the socket lever (Figure 11, J).



OM17215

Figure 11. Close the Load Plate

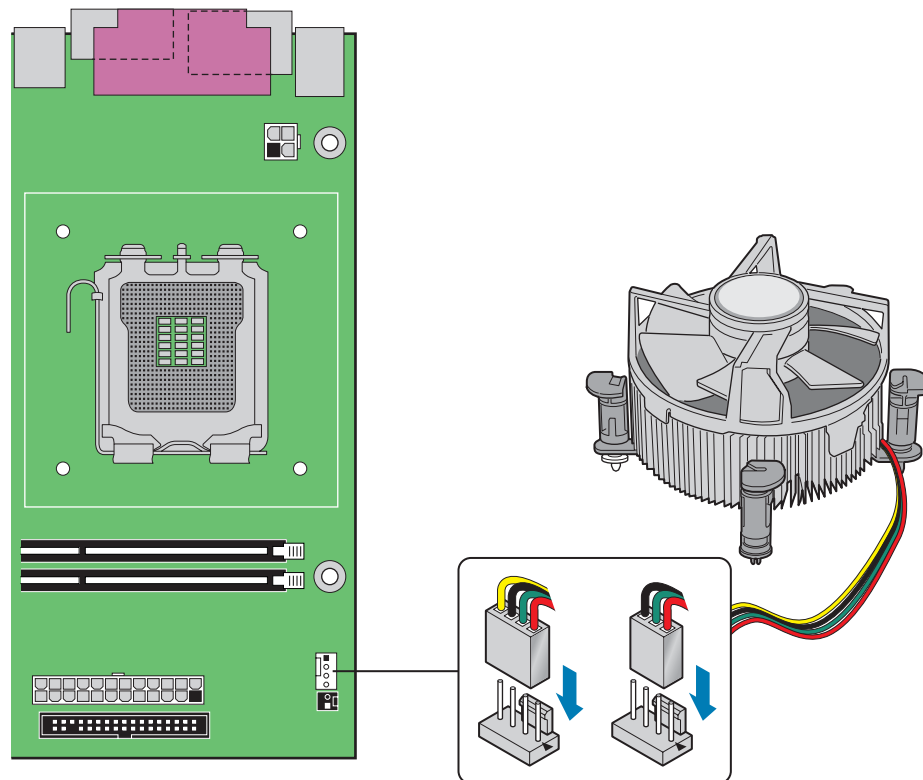
Installing the Processor Fan Heat Sink

Desktop board D101GGC has an integrated processor fan heat sink retention mechanism (RM). For instructions on how to attach the processor fan heat sink to the integrated processor fan heat sink RM, refer to the boxed processor manual or the Intel World Wide Web site at:

[The Boxed Intel® Pentium® 4 Processor in the 775-Land Package](#)

Connecting the Processor Fan Heat Sink Cable

Connect the processor fan heat sink cable to the 4-pin processor fan connector (see Figure 12).



OM18212

Figure 12. Connecting the Processor Fan Heat Sink Cable to the Processor Fan Connector

Removing the Processor

For instruction on how to remove the processor fan heat sink and processor, refer to the processor installation manual or the Intel World Wide Web site at:

[The Boxed Intel® Pentium® 4 Processor in the 775-Land Package](#)

Installing and Removing Memory



NOTE

To be fully compliant with all applicable Intel SDRAM memory specifications, the boards require DIMMs that support the Serial Presence Detect (SPD) data structure. You can access the PC Serial Presence Detect Specification at:

http://www.intel.com/technology/memory/ddr/specs/dda18c32_64_128x72ag_a.pdf

The desktop board has two 184-pin DIMM sockets arranged as DIMM 0 (blue) and DIMM 1 (black).

Installing DIMMs



NOTE

Install memory in the DIMM sockets prior to installing the PCI Express video card to avoid interference with the memory retention mechanism.

To make sure you have the correct DIMM, place it on the illustration in Figure 13 showing the DDR DIMM. All the notches should match the DDR DIMM.

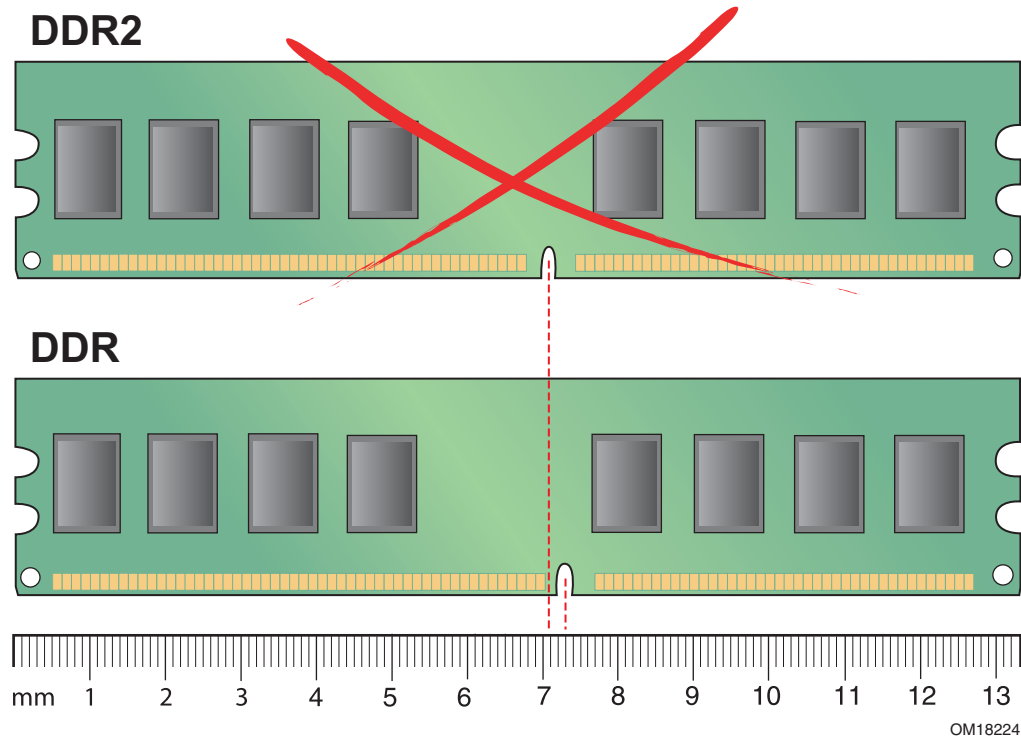
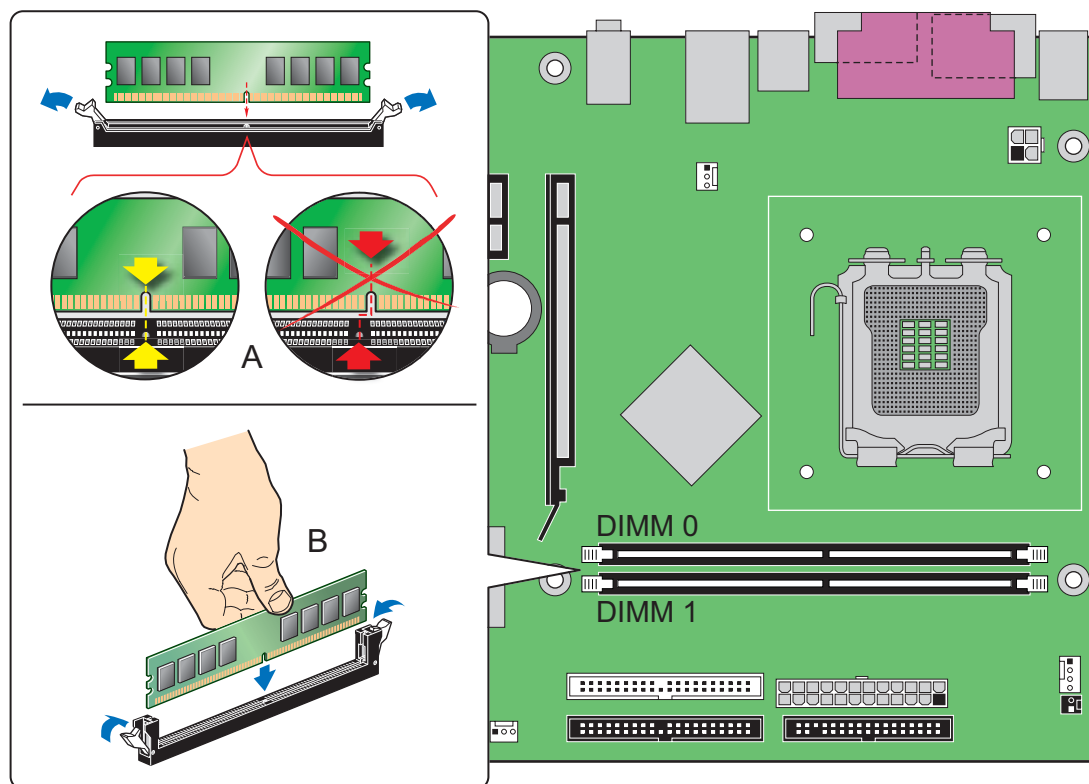


Figure 13. Use DDR DIMMs

1. Observe the precautions in "Before You Begin" on page 23.
2. Turn off all peripheral devices connected to the computer. Turn off the computer and disconnect the AC power cord.
3. Remove the computer's cover and locate the DIMM sockets (see Figure 14).



OM18213

Figure 14. Installing a DIMM

4. Remove the PCI Express video card if it interferes with the DIMM retaining clips from being easily opened and closed.
5. Make sure the clips at either end of the DIMM socket(s) are pushed outward to the open position.
6. Holding the DIMM by the edges, remove it from its anti-static package.
7. Position the DIMM above the socket. Align the small notch at the bottom edge of the DIMM with the key in the socket (see inset in Figure 14).
8. Insert the bottom edge of the DIMM into the socket.
9. When the DIMM is inserted, push down on the top edge of the DIMM until the retaining clips snap into place. Make sure the clips are firmly in place.
10. Reinstall the PCI Express card if it was removed prior to installing the DIMMs.
11. Replace the computer's cover and reconnect the AC power cord.

Removing DIMMs

To remove a DIMM, follow these steps:

1. Observe the precautions in "Before You Begin" on page 23.
2. Turn off all peripheral devices connected to the computer. Turn off the computer.
3. Remove the AC power cord from the computer.
4. Remove the computer's cover.
5. Remove the PCI Express card if it interferes with the DIMM clips from being easily opened and closed.
6. Gently spread the retaining clips at each end of the DIMM socket. The DIMM pops out of the socket.
7. Hold the DIMM by the edges, lift it away from the socket, and store it in an anti-static package.
8. Reinstall the PCI Express card if you removed it before taking out the DIMM.
9. Reinstall and reconnect any parts you removed or disconnected to reach the DIMM sockets.
10. Replace the computer's cover and reconnect the AC power cord.

Installing and Removing a PCI Express* x16 Card

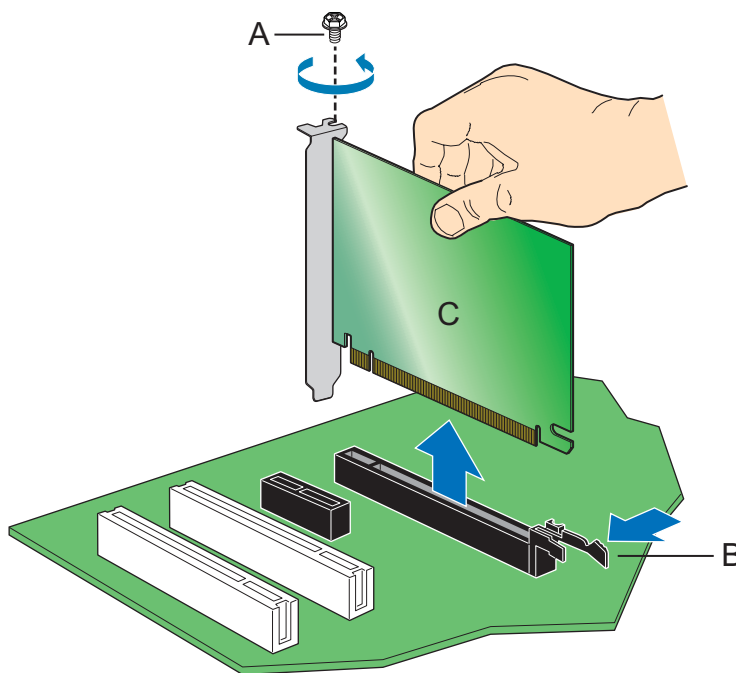


CAUTION

When installing a PCI Express x16 card on the desktop board, ensure that it is fully seated in the PCI Express x16 connector before you power on the system. If the card is not fully seated in the PCI Express connector, an electrical short may result across the PCI Express connector pins. Depending on the over-current protection of the power supply, certain board components and/or traces may be damaged.

Installing a PCI Express x16 Card

1. Observe the precautions in "Before You Begin" on page 23.
2. Place the card in the PCI Express x16 connector and press down on the card until it is completely seated in the connector and the card retention notch snaps into place around the RM pin (Figure 15, A).
3. Secure the card's metal bracket to the chassis back panel with a screw (Figure 15, B).



OM18214

Figure 15. Removing a PCI Express x16 Card

Removing the PCI Express x16 Card

Follow these instructions to remove the PCI Express x16 card from the RM:

1. Observe the precautions in "Before You Begin" on page 23.
2. Remove the screw that secures the card's metal bracket to the chassis back panel.
3. Push back on the RM lever until the retention pin completely clears the notch in the card.
4. Pull the card straight up.

Connecting the IDE Cable

The IDE cable can connect two drives to the desktop board. The cable supports the ATA-100 transfer protocol. Figure 16 shows the correct installation of the cable.



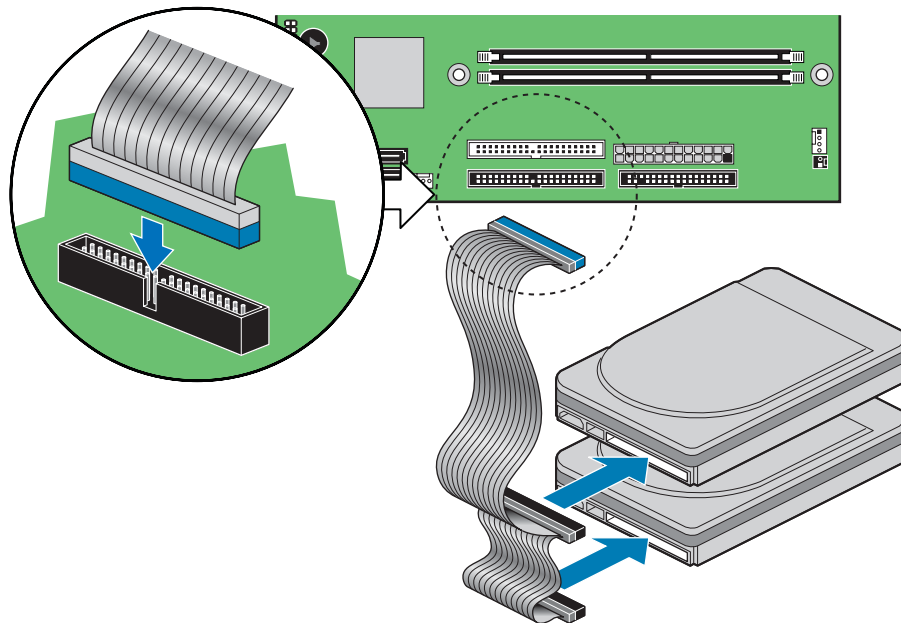
NOTES

ATA-100 compatible cables are backward compatible with drives using slower IDE transfer protocols. If an ATA-100 disk drive and a disk drive using any other IDE transfer protocol are attached to the same cable, the maximum transfer rate between the drives may be reduced to that of the slowest drive.

Do not connect an ATA device as a slave on the same IDE cable as an ATAPI master device. For example, do not connect an ATA hard drive as a slave to an ATAPI CD-ROM drive.

For correct function of the cable:

- Observe the precautions in "Before You Begin" on page 23.
- Attach the cable end with the single connector (blue) to the Intel desktop board (Figure 16).
- Attach the cable end with the two closely spaced connectors (gray and black) to the drives.



OM18215

Figure 16. Connecting the IDE Cable

Connecting the Serial ATA (SATA) Cable

The SATA cable (4-conductor) supports the Serial ATA protocol and connects a single drive to the desktop board. Either end of the cable can be connected to the SATA drive or the connector on the board.

For correct cable function:

1. Observe the precaution in "Before You Begin" on page 23.
2. Attach the locking cable end to the connector (Figure 17, A) on the board.
3. Attach the cable end without a lock to the drive (Figure 17, B).

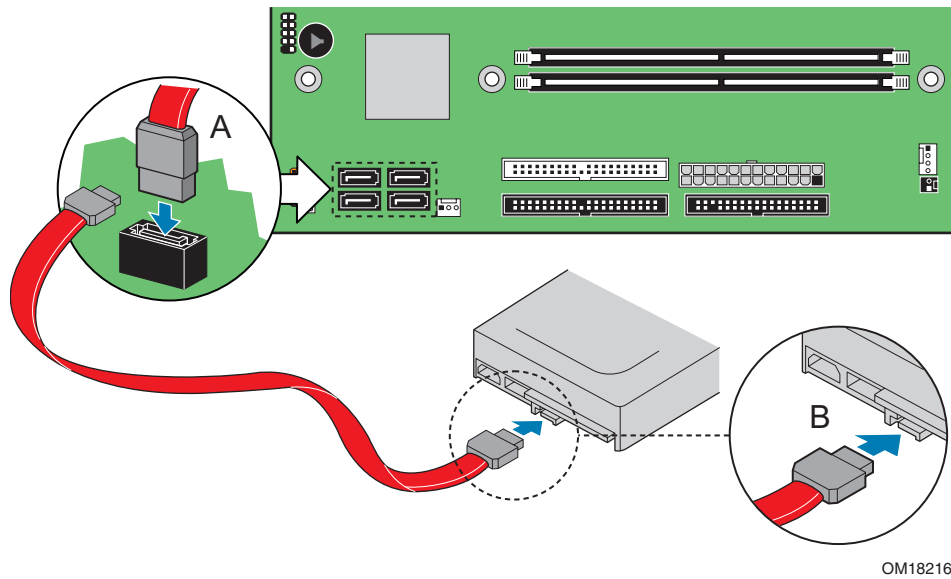
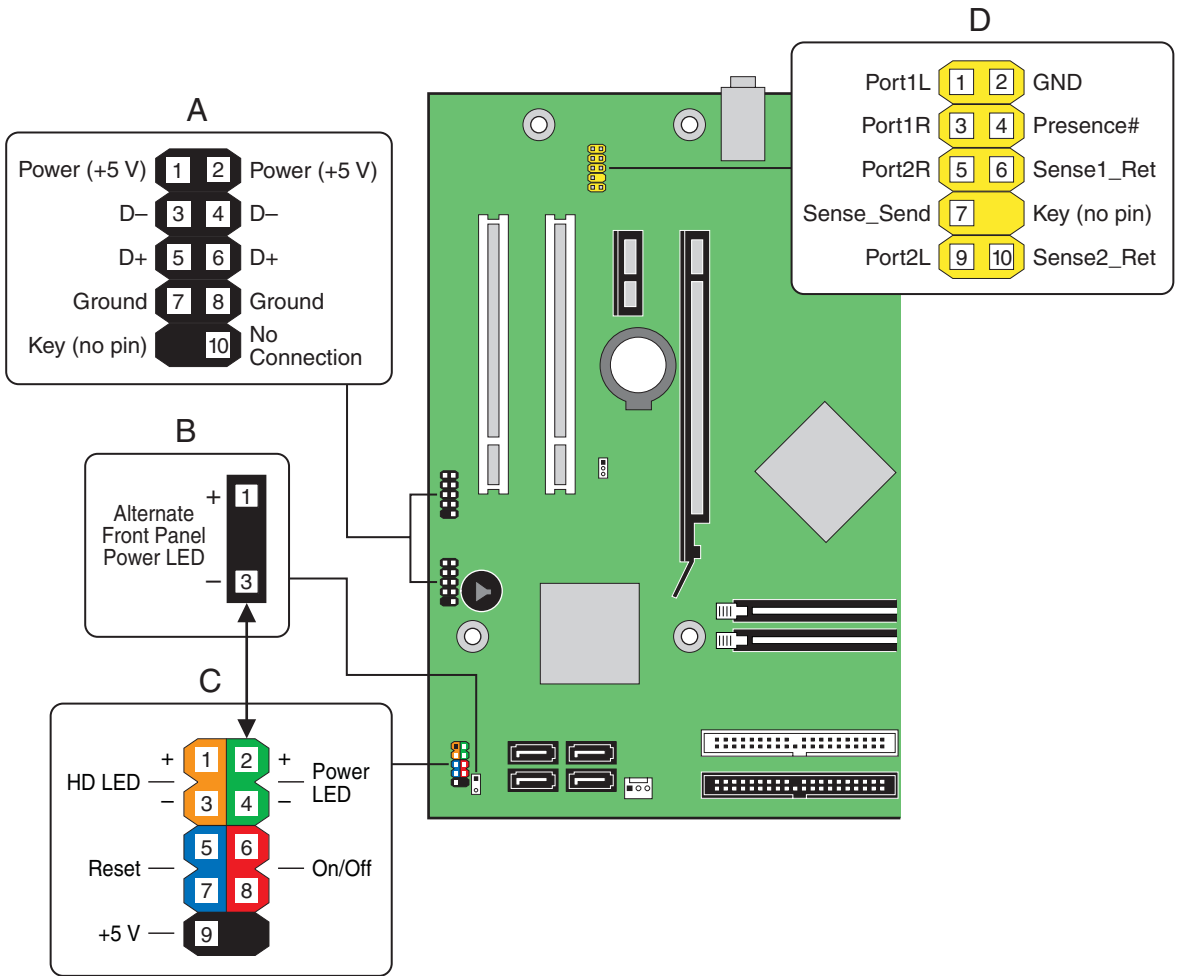


Figure 17. Connecting the Serial ATA Cable

Connecting Internal Headers

Before connecting cables to the internal headers, observe the precautions in "Before You Begin" on page 23. Figure 18 shows the location of the internal headers.



OM18217

Item	Description
A	Hi-speed USB 2.0 (two)
B	Alternate front panel power LED
C	Front panel
D	Front panel audio

Figure 18. Internal Headers

Installing a Front Panel Audio Solution for High Definition Audio

Figure 18, D on page 37 shows the location of the yellow front panel audio header. Table 5 shows the pin assignments for the front panel audio header.

Table 5. Front Panel Audio Header Signal Names for High Definition Audio

Pin	Signal Name	Pin	Signal Name
1	PORT 1L	2	GND
3	PORT 1R	4	PRESENCE#
5	PORT 2R	6	SENSE1_RETURN
7	SENSE_SEND	8	KEY (no pin)
9	PORT 2L	10	SENSE2_RETURN

To install the cable that connects the front panel audio solution to the front panel audio header, follow these steps:

1. Observe the precautions in "Before You Begin" on page 23.
2. Turn off all peripheral devices connected to the computer. Turn off the computer and disconnect the AC power cord.
3. Remove the cover.
4. Install a correctly keyed and shielded front panel audio cable.

NOTE: some chassis still use a front panel audio solution based on the AC '97 audio specification. Refer to Table 6 to connect an AC '97 front panel solution to the front panel audio header on the board. The front panel audio jacks will need to be manually configured for microphone or line out functionality in your audio software.

Table 6. AC '97 Audio Header Signal Names

Pin	Signal Name	Pin	Signal Name
1	MIC	2	AUD_GND
3	MIC_BIAS	4	AUD_GND
5	FP_OUT_R	6	FP_RETURN_R
7	AUD_5V	8	KEY
9	FP_OUT_L	10	FP_RETURN_L

5. Connect the audio cable to the front panel audio solution.
6. Replace the cover.

To restore back panel audio, follow these steps:

1. Observe the precautions in "Before You Begin" on page 23.
2. Turn off all peripheral devices connected to the computer. Turn off the computer and disconnect the AC power cord.
3. Remove the cover.
4. Remove the front panel audio cable.
5. Replace the cover.

Connecting Hi-Speed USB 2.0 Headers

Before connecting the USB 2.0 headers, observe the precautions in "Before You Begin" on page 23. See Figure 18, A on page 37 for the location of the black USB 2.0 headers.

Table 7 shows the pin assignments for the headers.

Table 7. Hi-Speed USB 2.0 Header Signal Names

USB Port A		USB Port B	
Pin	Signal name	Pin	Signal name
1	Power	2	Power
3	D-	4	D-
5	D+	6	D+
7	Ground	8	Ground
9	Key	10	No connect

Note: USB ports may be assigned as needed.

Connecting the Front Panel Header

Before connecting the front panel header, observe the precautions in "Before You Begin" on page 23. See Figure 18, C on page 37 for the location of the multi-colored front panel header.

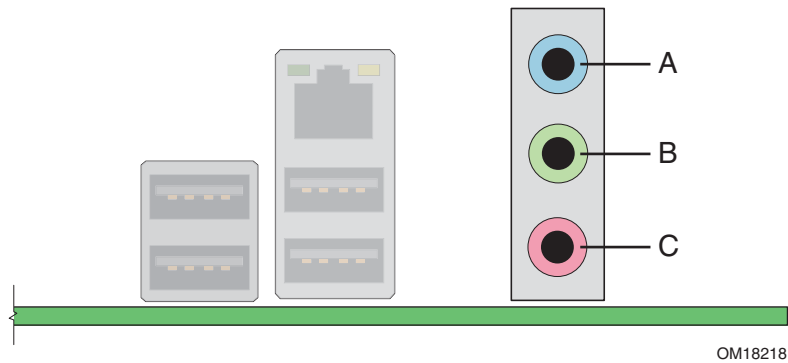
Table 8 shows the pin assignments for the front panel header.

Table 8. Front Panel Header Signal Names

Pin	Signal	In/Out	Description	Pin	Signal	In/Out	Description
Hard Drive Activity LED				Power LED			
1	HD_PWR	Out	Hard disk LED pull-up (330 Ω) to +5 V	2	HDR_BLNK_GRN	Out	Front panel green LED
3	HDA#	Out	Hard disk active LED	4	HDR_BLNK_YEL	Out	Front panel yellow LED
Reset Switch				On/Off Switch			
5	Ground		Ground	6	SWITCH_ON#	In	Power switch
7	FP_RESET#	In	Reset switch	8	Ground		Ground
Power				Not Connected			
9	+5 V		Power	10	N/C		No pin

Setting Up the Flexible 6-Channel Audio with Jack Re-tasking (Optional)

After installing the Realtek audio driver, the multi-channel audio feature can be enabled.



Item	Description
A	Rear left/right out or Line In
B	Front left/right out or Line Out
C	Center/LFE (Subwoofer) or Mic In

Figure 19. Back Panel Audio Connectors for Flexible 6-Channel Audio System

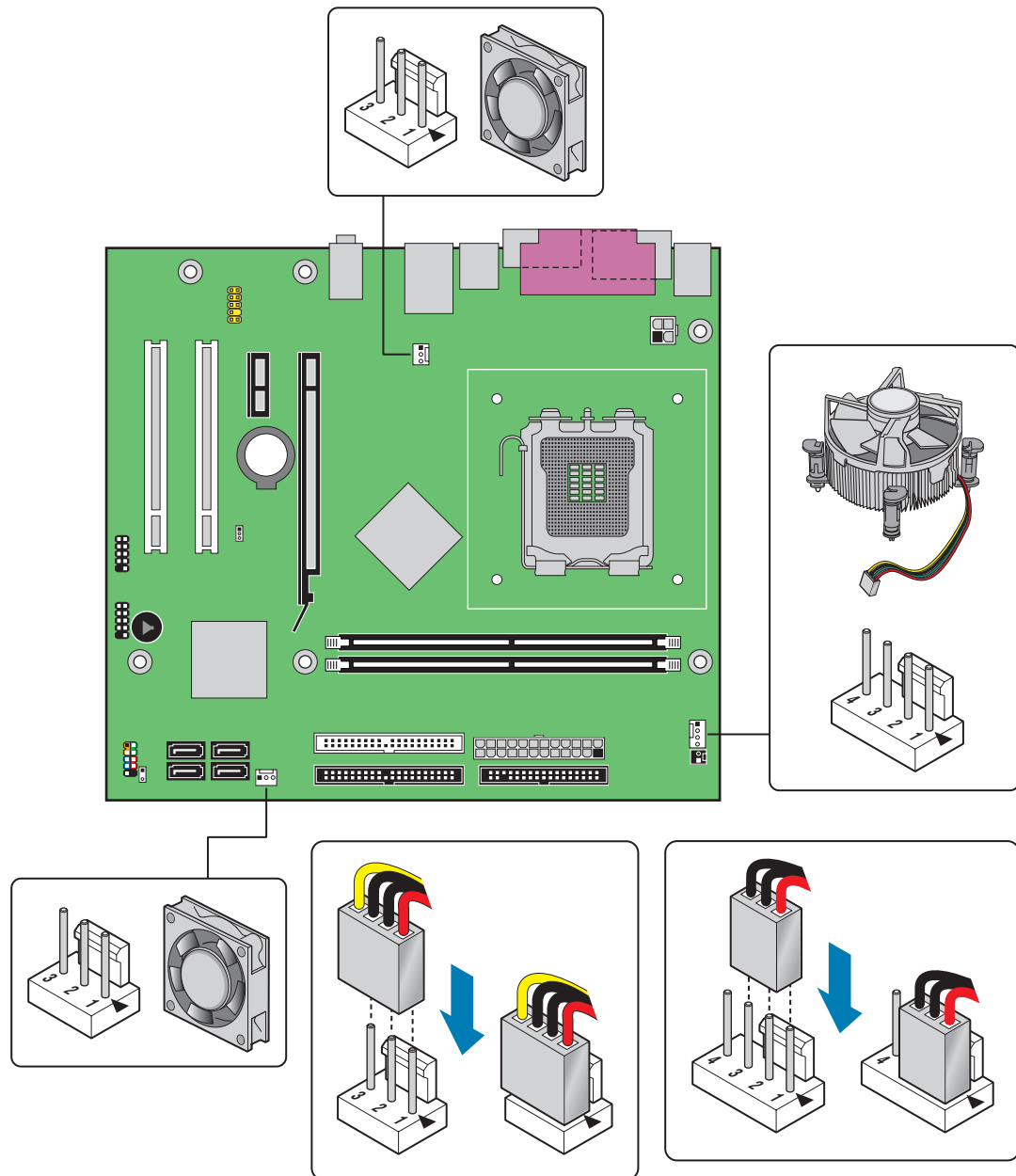
Multi-Channel Analog Audio

Connect two speakers to the front left/right out (B) and two speakers to the rear left/right out (A) for both 4- and 6-channel audio configurations. For 6-channel audio, connect two additional speakers to the center LFE out (C).

Connecting Fan and Power Cables

Connecting Fan Cables

Figure 20 shows the location of the fan headers. Connect the processor's fan heat sink cable to the 4-pin processor fan header on the board. Connect chassis fan cables to the 3-pin fan headers.



OM18219

Figure 20. Location of Fan Headers

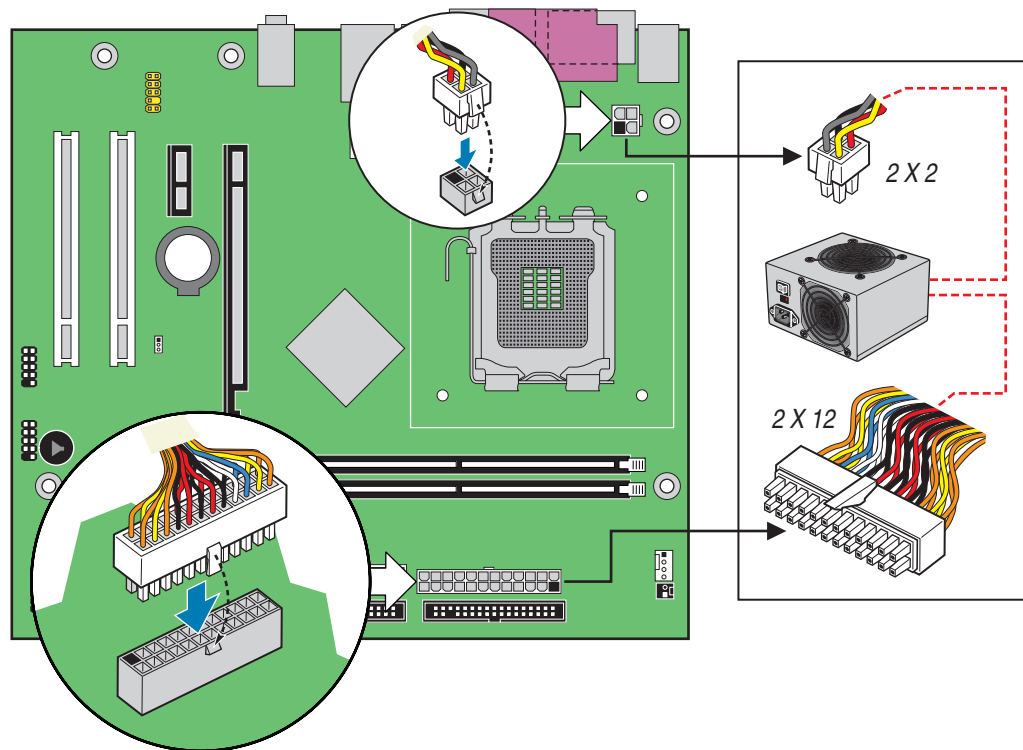
Connecting Power Cables



CAUTION

Failure to use the appropriate power supply and/or not connecting the 12 V (2x2) power connector to the desktop board may result in damage to the board or the system may not function properly.

See Table 3 on page 13 for power supply requirements. Figure 21 shows the location of the power connectors.



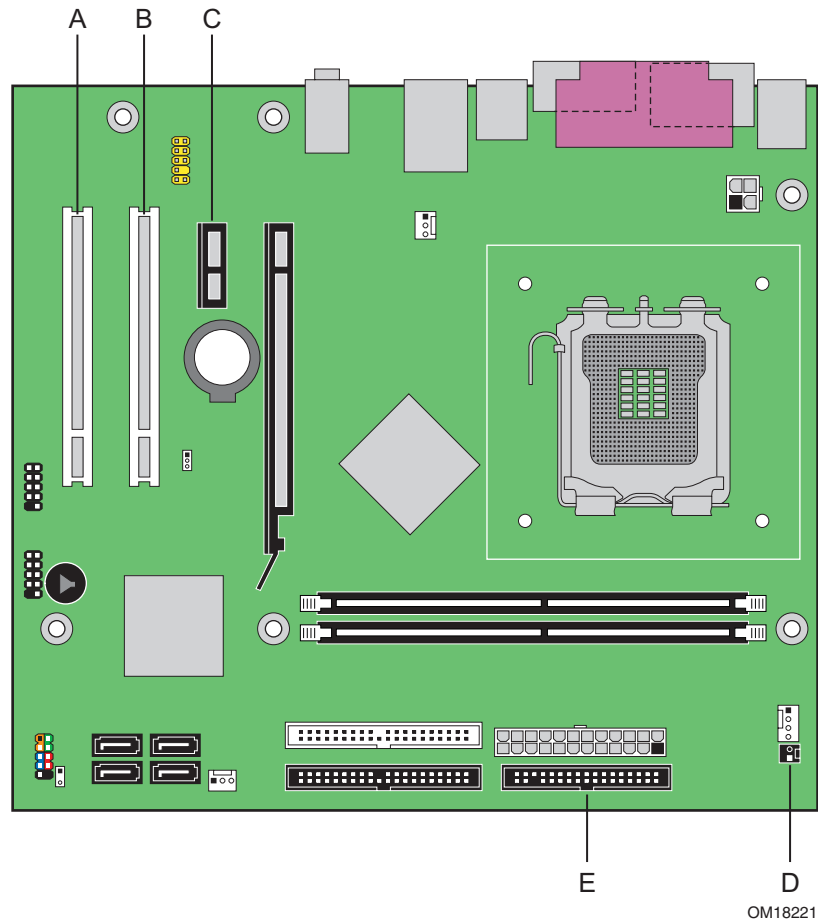
OM18220

Figure 21. Connecting 2x12 Power Supply Cables

1. Observe the precautions in "Before You Begin" on page 23.
2. Connect the 12 V processor core voltage power supply cable to the 2x2 connector.
3. Connect the main power supply cable to the 2x12 connector.

Other Connectors

Figure 22 shows the location of the PCI bus add-in card, PCI Express x1, chassis intrusion, and diskette drive connectors.



Item	Description
A	PCI bus add-in card connector 2
B	PCI bus add-in card connector 1
C	PCI Express x1 connector
D	Chassis intrusion connector
E	Diskette drive connector

Figure 22. Location of Other Connectors on Desktop Board D101GGC

Setting the BIOS Configuration Jumper



NOTE

Always turn off the power and unplug the power cord from the computer before changing the jumper. Moving the jumper with the power on may result in unreliable computer operation.

Figure 23 shows the location of the desktop board's BIOS configuration jumper block.

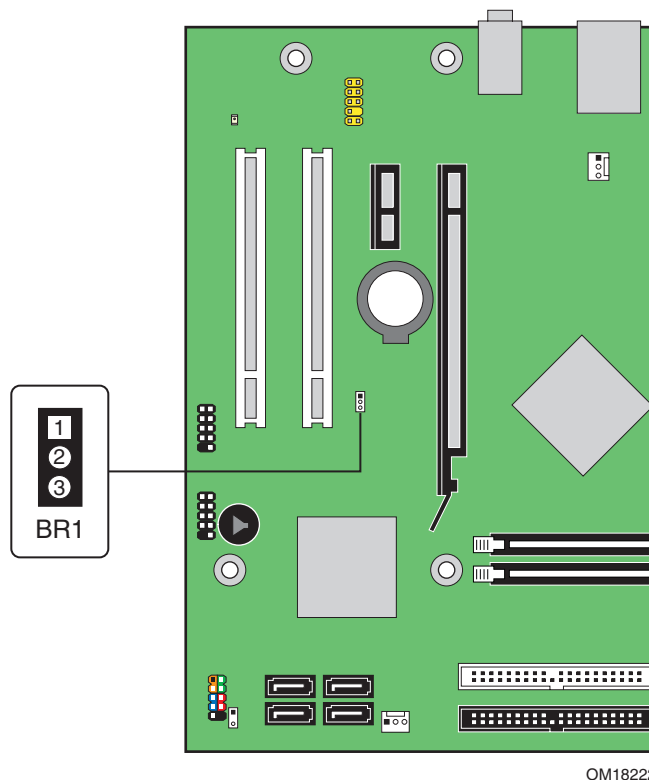





Figure 23. Location of the BIOS Configuration Jumper Block

The three-pin BIOS jumper block enables all board configuration to be done in the BIOS Setup program. Table 9 shows the jumper settings for the Setup program modes.

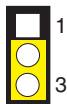
Table 9. Jumper Settings for the BIOS Setup Program Modes

Jumper Setting	Mode	Description
	Normal (default) (1-2)	The BIOS uses the current configuration and passwords for booting.
	Configure (2-3)	After the Power-On Self-Test (POST) runs, the BIOS displays the Maintenance Menu. Use this menu to clear passwords.
	Recovery (None)	The BIOS recovers data from a recovery diskette in the event of a failed BIOS update.

Clearing Passwords

This procedure assumes that the board is installed in the computer and the configuration jumper is set to normal mode.

1. Observe the precautions in "Before You Begin" on page 23.
2. Turn off all peripheral devices connected to the computer. Turn off the computer. Disconnect the computer's power cord from the AC power source (wall outlet or power adapter).
3. Remove the computer cover.
4. Find the configuration jumper block (see Figure 23).
5. Place the jumper on pins 2-3 as shown below.



6. Replace the cover, plug in the computer, turn on the computer, and allow it to boot.
7. The computer starts the Setup program. Setup displays the Maintenance menu.
8. Use the arrow keys to select Clear Passwords. Press <Enter> and Setup displays a pop-up screen requesting that you confirm clearing the password. Select Yes and press <Enter>. Setup displays the maintenance menu again.
9. Press <F10> to save the current values and exit Setup.
10. Turn off the computer. Disconnect the computer's power cord from the AC power source.
11. Remove the computer cover.
12. To restore normal operation, place the jumper on pins 1-2 as shown below.



13. Replace the cover, plug in the computer, and turn on the computer.

Replacing the Battery

A coin-cell battery (CR2032) powers the real-time clock and CMOS memory. When the computer is not plugged into a wall socket, the battery has an estimated life of three years. When the computer is plugged in, the standby current from the power supply extends the life of the battery. The clock is accurate to ± 13 minutes/year at 25 °C with 3.3 VSB applied.

When the voltage drops below a certain level, the BIOS Setup program settings stored in CMOS RAM (for example, the date and time) might not be accurate. Replace the battery with an equivalent one. Figure 24 on page 50 shows the location of the battery.



CAUTION

Risk of explosion if the battery is replaced with an incorrect type. Batteries should be recycled where possible. Disposal of used batteries must be in accordance with local environmental regulations.



PRECAUTION

Risque d'explosion si la pile usagée est remplacée par une pile de type incorrect. Les piles usagées doivent être recyclées dans la mesure du possible. La mise au rebut des piles usagées doit respecter les réglementations locales en vigueur en matière de protection de l'environnement.



FORHOLDSREGEL

Eksplodingsfare, hvis batteriet erstattes med et batteri af en forkert type. Batterier bør om muligt genbruges. Bortskaffelse af brugte batterier bør foregå i overensstemmelse med gældende miljølovgivning.



OBS!

Det kan oppstå eksplosjonsfare hvis batteriet skiftes ut med feil type. Brukte batterier bør kastes i henhold til gjeldende miljølovgivning.



VIKTIGT!

Risk för explosion om batteriet ersätts med felaktig batterityp. Batterier ska kasseras enligt de lokala miljövårdsbestämmelserna.



VARO

Räjähdysvaara, jos pariston tyyppi on väärä. Paristot on kierrätettävä, jos se on mahdollista. Käytetyt paristot on hävitettävä paikallisten ympäristömääräysten mukaisesti.



VORSICHT

Bei falschem Einsetzen einer neuen Batterie besteht Explosionsgefahr. Die Batterie darf nur durch denselben oder einen entsprechenden, vom Hersteller empfohlenen Batterietyp ersetzt werden. Entsorgen Sie verbrauchte Batterien den Anweisungen des Herstellers entsprechend.

**AVVERTIMENTO**

Esiste il pericolo di un esplosione se la pila non viene sostituita in modo corretto. Utilizzare solo pile uguali o di tipo equivalente a quelle consigliate dal produttore. Per disfarsi delle pile usate, seguire le istruzioni del produttore.

**PRECAUCIÓN**

Existe peligro de explosión si la pila no se cambia de forma adecuada. Utilice solamente pilas iguales o del mismo tipo que las recomendadas por el fabricante del equipo. Para deshacerse de las pilas usadas, siga igualmente las instrucciones del fabricante.

**WAARSCHUWING**

Er bestaat ontploffingsgevaar als de batterij wordt vervangen door een onjuist type batterij. Batterijen moeten zoveel mogelijk worden gerecycled. Houd u bij het weggooien van gebruikte batterijen aan de plaatselijke milieuwetgeving.

**ATENÇÃO**

Haverá risco de explosão se a bateria for substituída por um tipo de bateria incorreto. As baterias devem ser recicladas nos locais apropriados. A eliminação de baterias usadas deve ser feita de acordo com as regulamentações ambientais da região.

**AŚCIAROŻŻNAŚĆ**

Існуе рызыка выбуху, калі заменены акумулятар непраўльнага тыпу. Акумулятары павінны, на магчымасці, перепрацоўвацца. Пазбаўляцца ад старых акумулятараў патрэбна згодна з мясцовымі заканадаўствам на экалогіі.

**UPOZORNĚNÍ**

V případě výměny baterie za nesprávný druh může dojít k výbuchu. Je-li to možné, baterie by měly být recyklovány. Baterie je třeba zlikvidovat v souladu s místními předpisy o životním prostředí.

**Προσοχή**

Υπάρχει κίνδυνος για έκρηξη σε περίπτωση που η μπαταρία αντικατασταθεί από μία λανθασμένου τύπου. Οι μπαταρίες θα πρέπει να ανακυκλώνονται όταν κάτι τέτοιο είναι δυνατό. Η απόρριψη των χρησιμοποιημένων μπαταριών πρέπει να γίνεται σύμφωνα με τους κατά τόπο περιβαλλοντικούς κανονισμούς.

**VIGYAZAT**

Ha a telepet nem a megfelelő típusú telepre cseréli, az felrobbanhat. A telepeket lehetőség szerint újra kell hasznosítani. A használt telepeket a helyi környezetvédelmi előírásoknak megfelelően kell kiselejtezni.



注意

異なる種類の電池を使用すると、爆発の危険があります。リサイクルが可能な地域であれば、電池をリサイクルしてください。使用後の電池を破棄する際には、地域の環境規制に従ってください。



AWAS

Risiko letupan wujud jika bateri digantikan dengan jenis yang tidak betul. Bateri sepatutnya dikitar semula jika boleh. Pelupusan bateri terpakai mestilah mematuhi peraturan alam sekitar tempatan.



OSTRZEŻENIE

Istnieje niebezpieczeństwo wybuchu w przypadku zastosowania niewłaściwego typu baterii. Zużyte baterie należy w miarę możliwości utylizować zgodnie z odpowiednimi przepisami ochrony środowiska.



PRECAUȚIE

Risc de explozie, dacă bateria este înlocuită cu un tip de baterie necorespunzător. Bateriile trebuie reciclate, dacă este posibil. Depozitarea bateriilor uzate trebuie să respecte reglementările locale privind protecția mediului.



ВНИМАНИЕ

При использовании батарей несоответствующего типа существует риск ее взрыва. Батареи должны быть утилизированы по возможности. Утилизация батарей должна проводиться по правилам, соответствующим местным требованиям.



UPOZORNENIE

Ak batériu vymeníte za nesprávny typ, hrozí nebezpečenstvo jej výbuchu. Batérie by sa mali podľa možnosti vždy recyklovať. Likvidácia použitých batérií sa musí vykonávať v súlade s miestnymi predpismi na ochranu životného prostredia.



POZOR

Zamenjava baterije z baterijo drugačnega tipa lahko povzroči eksplozijo. Če je mogoče, baterije reciklirajte. Rabljene baterije zavržite v skladu z lokalnimi okoljevarstvenimi predpisi.



คำเตือน

ระวังการระเบิดที่เกิดจากเปลี่ยนแบตเตอรี่ผิดประเภท หากเป็นไปได้ ควรนำแบตเตอรี่ไปรีไซเคิล การทิ้งแบตเตอรี่ใช้แล้วต้องเป็นไปตามกฎข้อบังคับด้านสิ่งแวดล้อมของท้องถิ่น.



UYARI

Yanlış türde pil takıldığında patlama riski vardır. Piller mümkün olduğunda geri dönüştürülmelidir. Kullanılmış piller, yerel çevre yasalarına uygun olarak atılmalıdır.

**ОСТОРОГА**

Використовуйте батареї правильного типу, інакше існуватиме ризик вибуху. Якщо можливо, використані батареї слід утилізувати. Утилізація використаних батарей має бути виконана згідно місцевих норм, що регулюють охорону довкілля.

**UPOZORNĚNÍ**

V případě výměny baterie za nesprávný druh může dojít k výbuchu. Je-li to možné, baterie by měly být recyklovány. Baterie je třeba zlikvidovat v souladu s místními předpisy o životním prostředí.

**ETTEVAATUST**

Kui patarei asendatakse uue ebasobivat tüüpi patareiga, võib tekkida plahvatusoht. Tühjade patareid tuleb võimaluse korral viia vastavasse kogumispunkti. Tühjade patareide äraviskamisel tuleb järgida kohalikke keskkonnakaitse alaseid reegleid.

**FIGYELMEZTETÉS**

Ha az elemet nem a megfelelő típusúra cseréli, felrobbanhat. Az elemeket lehetőség szerint újra kell hasznosítani. A használt elemeket a helyi környezetvédelmi előírásoknak megfelelően kell kiselejtezni.

**UZMANĪBU**

Pastāv eksplozijas risks, ja baterijas tiek nomainītas ar nepareiza veida baterijām. Ja iespējams, baterijas vajadzētu nodot attiecīgos pieņemšanas punktus. Bateriju izmešanai atkritumos jānotiek saskaņā ar vietējiem vides aizsardzības noteikumiem.

**DÉMESIO**

Naudojant netinkamo tipo baterijas įrenginys gali sprogti. Kai tik įmanoma, baterijas reikia naudoti pakartotinai. Panaudotas baterijas išmesti būtina pagal vietinius aplinkos apsaugos nuostatus.

**ATTENZJONI**

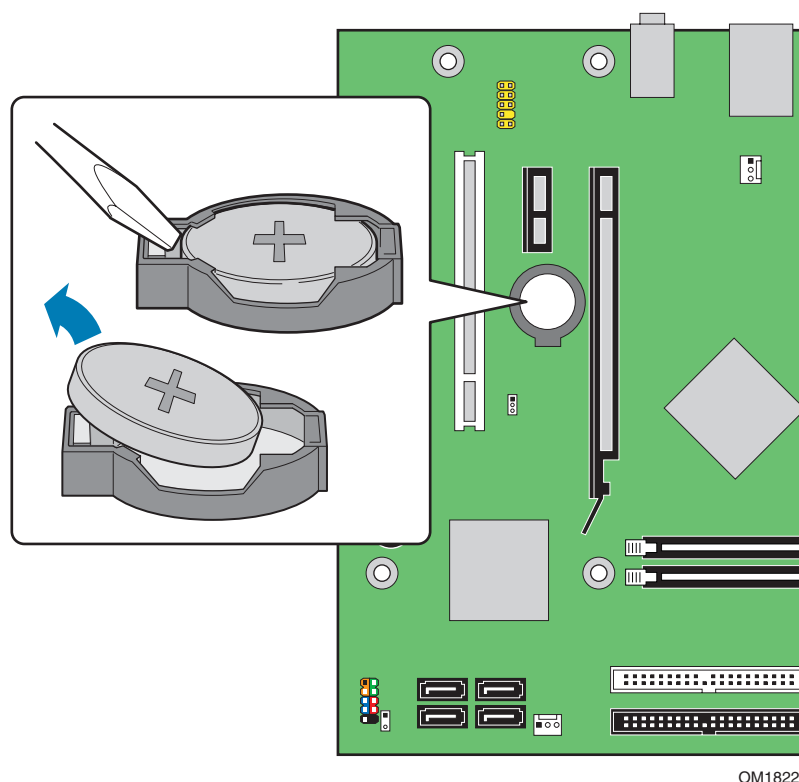
Riskju ta' splużjoni jekk il-batterija tinbidel b'tip ta' batterija mhux korrett. Il-batteriji għandhom jiġu riċiklati fejn hu possibbli. Ir-rimi ta' batteriji użati għandu jsir skond ir-regolamenti ambjentali lokali.

**OSTRZEŻENIE**

Ryzyko wybuchu w przypadku wymiany na baterie niewłaściwego typu. W miarę możliwości baterie należy poddać recyklingowi. Zużytych baterii należy pozbywać się zgodnie z lokalnie obowiązującymi przepisami w zakresie ochrony środowiska.

To replace the battery, follow these steps:

1. Observe the precautions in "Before You Begin" (see page 23).
2. Turn off all peripheral devices connected to the computer. Disconnect the computer's power cord from the AC power source (wall outlet or power adapter).
3. Remove the computer cover.
4. Locate the battery on the board (see Figure 24).
5. With a medium flat-bladed screwdriver, gently pry the battery free from its connector. Note the orientation of the "+" and "-" on the battery.
6. Install the new battery in the connector, orienting the "+" and "-" correctly.
7. Replace the computer cover.



OM18223

Figure 24. Removing the Battery

A Regulatory Compliance

This appendix contains the following regulatory compliance information for desktop board D101GGC:

- Safety regulations
- European Union Declaration of Conformity statement
- Product Ecology statements
- Electromagnetic Compatibility (EMC) regulations
- Product certifications

Safety Regulations

Desktop board D101GGC complies with the safety regulations stated in Table 10 when correctly installed in a compatible host system.

Table 10. Safety Regulations

Regulation	Title
UL 60950-1:2003/ CSA C22.2 No. 60950-1-03	Information Technology Equipment – Safety - Part 1: General Requirements (USA and Canada)
EN 60950-1:2002	Information Technology Equipment – Safety - Part 1: General Requirements (European Union)
IEC 60950-1:2001, First Edition	Information Technology Equipment – Safety - Part 1: General Requirements (International)

Place Battery Marking

There is insufficient space on this desktop board to provide instructions for replacing and disposing of the Lithium ion coin cell battery. For system safety certification, the below statement or equivalent statement is required to be permanently and legibly marked on the chassis near the battery.



CAUTION

Risk of explosion if the battery is replaced with an incorrect type. Batteries should be recycled where possible. Disposal of used batteries must be in accordance with local environmental regulations.

Related Links:

For information about replacing the battery, go to page 46.

European Union Declaration of Conformity Statement

We, Intel Corporation, declare under our sole responsibility that the product Intel® Desktop Board D101GGC is in conformity with all applicable essential requirements necessary for CE marking, following the provisions of the European Council Directive 89/336/EEC (EMC Directive) and Council Directive 73/23/EEC (Safety/Low Voltage Directive).

The product is properly CE marked demonstrating this conformity and is for distribution within all member states of the EU with no restrictions.



This product follows the provisions of the European Directives 89/336/EEC and 73/23/EEC.

Čeština Tento výrobek odpovídá požadavkům evropských směrnic 89/336/EEC a 73/23/EEC.

Dansk Dette produkt er i overensstemmelse med det europæiske direktiv 89/336/EEC & 73/23/EEC.

Dutch Dit product is in navolging van de bepalingen van Europees Directief 89/336/EEC & 73/23/EEC.

Eesti Antud toode vastab Euroopa direktiivides 89/336/EEC ja 73/23/EEC kehtestatud nõuetele.

Suomi Tämä tuote noudattaa EU-direktiivin 89/336/EEC & 73/23/EEC määräyksiä.

Français Ce produit est conforme aux exigences de la Directive Européenne 89/336/EEC & 73/23/EEC.

Deutsch Dieses Produkt entspricht den Bestimmungen der Europäischen Richtlinie 89/336/EEC & 73/23/EEC.

Ελληνικά Το παρόν προϊόν ακολουθεί τις διατάξεις των Ευρωπαϊκών Οδηγιών 89/336/ΕΟΚ και 73/23/ΕΟΚ.

Magyar E termék megfelel a 89/336/EEC és 73/23/EEC Európai Irányelv előírásainak.

Icelandic Þessi vara stenst reglugerð Evrópska Efnahags Bandalagsins númer 89/336/ EEC & 73/23/EEC.

Italiano Questo prodotto è conforme alla Direttiva Europea 89/336/EEC & 73/23/EEC.

Latviešu Šis produkts atbilst Eiropas Direktīvu 89/336/EEC un 73/23/EEC noteikumiem.

Lietuvių Šis produktas atitinka Europos direktyvų 89/336/EEC ir 73/23/EEC nuostatas.

Malti Dan il-prodott hu konformi mal-provvedimenti tad-Direttivi Ewropej 89/336/EEC u 73/23/EEC.

Norsk Dette produktet er i henhold til bestemmelsene i det europeiske direktivet 89/336/ EEC & 73/23/EEC.

Polski Niniejszy produkt jest zgodny z postanowieniami Dyrektyw Unii Europejskiej 89/336/EWG i 73/23/EWG.

Portuguese Este produto cumpre com as normas da Diretiva Europeia 89/336/EEC & 73/23/EEC.

Español Este producto cumple con las normas del Directivo Europeo 89/336/EEC & 73/23/EEC.

Slovensky Tento produkt je v súlade s ustanoveniami európskych direktív 89/336/EEC a 73/23/EEC.

Slovenščina Izdelek je skladen z določbami evropskih direktiv 89/336/EGS in 73/23/EGS.

Svenska Denna produkt har tillverkats i enlighet med EG-direktiv 89/336/EEC & 73/23/EEC.

Türkçe Bu ürün, Avrupa Birliği'nin 89/336/EEC ve 73/23/EEC yönergelerine uyar.

Product Ecology Statements

The following information is provided to address worldwide product ecology concerns and regulations.

Recycling Considerations

As part of its commitment to environmental responsibility, Intel has implemented the Intel Product Recycling Program to allow retail consumers of Intel's branded products to return used products to select locations for proper recycling.

Please consult the http://www.intel.com/intel/other/ehs/product_ecology/Recycling_Program.htm for the details of this program, including the scope of covered products, available locations, shipping instructions, terms and conditions, etc.

中文

作为其对环境责任之承诺的部分，英特尔已实施 Intel Product Recycling Program（英特尔产品回收计划），以允许英特尔品牌产品的零售消费者将使用过的产品退还至指定地点作恰当的重复使用处理。

请参考http://www.intel.com/intel/other/ehs/product_ecology/Recycling_Program.htm了解此计划的详情，包括涉及产品之范围、回收地点、运送指导、条款和条件等。

Deutsch

Als Teil von Intels Engagement für den Umweltschutz hat das Unternehmen das Intel Produkt-Recyclingprogramm implementiert, das Einzelhandelskunden von Intel Markenprodukten ermöglicht, gebrauchte Produkte an ausgewählte Standorte für ordnungsgemäßes Recycling zurückzugeben.

Details zu diesem Programm, einschließlich der darin eingeschlossenen Produkte, verfügbaren Standorte, Versandanweisungen, Bedingungen usw., finden Sie auf der http://www.intel.com/intel/other/ehs/product_ecology/Recycling_Program.htm

Español

Como parte de su compromiso de responsabilidad medioambiental, Intel ha implantado el programa de reciclaje de productos Intel, que permite que los consumidores al detalle de los productos Intel devuelvan los productos usados en los lugares seleccionados para su correspondiente reciclado.

Consulte la http://www.intel.com/intel/other/ehs/product_ecology/Recycling_Program.htm para ver los detalles del programa, que incluye los productos que abarca, los lugares disponibles, instrucciones de envío, términos y condiciones, etc.

Français

Dans le cadre de son engagement pour la protection de l'environnement, Intel a mis en œuvre le programme Intel Product Recycling Program (Programme de recyclage des produits Intel) pour permettre aux consommateurs de produits Intel de recycler les produits usés en les retournant à des adresses spécifiées.

Visitez la page Web http://www.intel.com/intel/other/ehs/product_ecology/Recycling_Program.htm pour en savoir plus sur ce programme, à savoir les produits concernés, les adresses disponibles, les instructions d'expédition, les conditions générales, etc.

日本語

インテルでは、環境保護活動の一環として、使い終わったインテルブランド製品を指定の場所へ返送していただき、リサイクルを適切に行えるよう、インテル製品リサイクルプログラムを発足させました。

対象製品、返送先、返送方法、ご利用規約など、このプログラムの詳細情報は、http://www.intel.com/intel/other/ehs/product_ecology/Recycling_Program.htm (英語)をご覧ください。

Malay

Sebagai sebahagian daripada komitmennya terhadap tanggungjawab persekitaran, Intel telah melaksanakan Program Kitar Semula Produk untuk membenarkan pengguna-pengguna runcit produk jenama Intel memulangkan produk terguna ke lokasi-lokasi terpilih untuk dikitarkan semula dengan betul.

Sila rujuk http://www.intel.com/intel/other/ehs/product_ecology/Recycling_Program.htm untuk mendapatkan butir-butir program ini, termasuklah skop produk yang dirangkumi, lokasi-lokasi tersedia, arahan penghantaran, terma & syarat, dsb.

Portuguese

Como parte deste compromisso com o respeito ao ambiente, a Intel implementou o Programa de Reciclagem de Produtos para que os consumidores finais possam enviar produtos Intel usados para locais selecionados, onde esses produtos são reciclados de maneira adequada.

Consulte o site http://www.intel.com/intel/other/ehs/product_ecology/Recycling_Program.htm (em Inglês) para obter os detalhes sobre este programa, inclusive o escopo dos produtos cobertos, os locais disponíveis, as instruções de envio, os termos e condições, etc.

Russian

В качестве части своих обязательств к окружающей среде, в Intel создана программа утилизации продукции Intel (Product Recycling Program) для предоставления конечным пользователям марок продукции Intel возможности возврата используемой продукции в специализированные пункты для должной утилизации.

Пожалуйста, обратитесь на веб-сайт http://www.intel.com/intel/other/ehs/product_ecology/Recycling_Program.htm за информацией об этой программе, принимаемых продуктах, местах приема, инструкциях об отправке, положениях и условиях и т.д.

Türkçe

Intel, çevre sorumluluğuna bağlılığının bir parçası olarak, perakende tüketicilerin Intel markalı kullanılmış ürünlerini belirlenmiş merkezlere iade edip uygun şekilde geri dönüştürmesini amaçlayan Intel Ürünleri Geri Dönüşüm Programı'nı uygulamaya koymuştur.

Bu programın ürün kapsamı, ürün iade merkezleri, nakliye talimatları, kayıtlar ve şartlar v.s dahil bütün ayrıntılarını öğrenmek için lütfen




http://www.intel.com/intel/other/ehs/product_ecology/Recycling_Program.htm

web sayfasına gidin.

Lead-Free Desktop Board

This desktop board is lead free although certain discrete components used on the board contain a small amount of lead which is necessary for component performance and/or reliability. This desktop board is referred to as "Lead-free second level interconnect." The board substrate and the solder connections from the board to the components (second-level connections) are all lead free. Table 11 shows the various forms of the "Lead-Free 2nd Level Interconnect" mark as it appears on the board and accompanying collateral.

Table 11. Lead-Free Board Markings

Description	Mark
Lead-Free 2nd Level Interconnect: This symbol is used to identify electrical and electronic assemblies and components in which the lead (Pb) concentration level in the desktop board substrate and the solder connections from the board to the components (second-level interconnect) is not greater than 0.1% by weight (1000 ppm).	<div style="border: 1px solid black; padding: 10px; text-align: center;">  2nd Level Interconnect </div> <p style="text-align: center;">or</p> <div style="border: 1px solid black; padding: 10px; text-align: center;">  2nd lvl Intct </div> <p style="text-align: center;">or</p> <div style="border: 1px solid black; padding: 10px; text-align: center;">  2LI </div>

EMC Regulations

Desktop board D101GGC complies with the EMC regulations stated in Table 12 when correctly installed in a compatible host system.

Table 12. EMC Regulations

Regulation	Title
FCC Class B	Title 47 of the Code of Federal Regulations, Parts 2 and 15, Subpart B, Radio Frequency Devices. (USA)
ICES-003 (Class B)	Interference-Causing Equipment Standard, Digital Apparatus. (Canada)
EN55022: 1998 (Class B)	Limits and methods of measurement of Radio Interference Characteristics of Information Technology Equipment. (European Union)
EN55024: 1998	Information Technology Equipment – Immunity Characteristics Limits and methods of measurement. (European Union)
AS/NZS CISPR 22 (Class B)	Australian Communications Authority, Standard for Electromagnetic Compatibility. (Australia and New Zealand)
CISPR 22, 3rd Edition, (Class B)	Limits and methods of measurement of Radio Disturbance Characteristics of Information Technology Equipment. (International)
CISPR 24: 1997	Information Technology Equipment – Immunity Characteristics – Limits and Methods of Measurement. (International)
VCCI (Class B)	Voluntary Control for Interference by Information Technology Equipment (Japan)

Japanese Kanji statement translation: This is a Class B product based on the standard of the Voluntary Control Council for Interference from Information Technology Equipment (VCCI). If this is used near a radio or television receiver in a domestic environment, it may cause radio interference. Install and use the equipment according to the instruction manual.

この装置は、情報処理装置等電波障害自主規制協議会（VCCI）の基準に基づくクラスB 情報技術装置です。この装置は、家庭環境で使用することを目的としていますが、この装置がラジオやテレビジョン受信機に近接して使用されると、受信障害を引き起こすことがあります。
取扱説明書に従って正しい取り扱いをして下さい。

Korean Class B statement translation: This is household equipment that is certified to comply with EMC requirements. You may use this equipment in residential environments and other non-residential environments.

이 기기는 가정용으로 전자파적합등록을 한 기기로서
주거지역에서는 물론 모든 지역에서 사용할 수 있습니다.

Ensure System EMC Compliance

Before system integration, make sure that the power supply and other modules or peripherals, as applicable, have passed Class B EMC testing and are marked accordingly.

Pay close attention to the following when reading the installation instructions for the chassis, power supply, and other modules:

- Product certifications or lack of certifications
- External I/O cable shielding and filtering
- Mounting, grounding, and bonding requirements
- Keying connectors when mating the wrong connectors could be hazardous








If the power supply and other modules or peripherals, as applicable, are not Class B EMC compliant before integration, then EMC testing may be required on a representative sample of the newly completed computer.

Product Certifications

Board-Level Certification Markings

Desktop board D101GGC has the product certification markings shown in Table 13:

Table 13. Product Certification Markings

Description	Mark
UL joint US/Canada Recognized Component mark. Includes adjacent UL file number for Intel desktop boards: E210882.	
FCC Declaration of Conformity logo mark for Class B equipment. Includes Intel name and D101GGC model designation.	
CE mark. Declaring compliance to European Union (EU) EMC directive (89/336/EEC) and Low Voltage directive (73/23/EEC).	
Australian Communications Authority (ACA) C-tick mark. Includes adjacent Intel supplier code number, N-232.	
Japan VCCI (Voluntary Control Council for Interference) mark.	
S. Korea MIC (Ministry of Information and Communication) mark. For information about MIC certification, go to http://support.intel.com/support/motherboards/desktop/	
Taiwan BSMI (Bureau of Standards, Metrology and Inspections) mark. Includes adjacent Intel company number, D33025.	
Printed wiring board manufacturer's recognition mark. Consists of a unique UL recognized manufacturer's logo, along with a flammability rating (solder side).	V-0

Chassis and Component Certifications

Ensure that the chassis and certain components; such as the power supply, peripheral drives, wiring, and cables; are components certified for the country or market where used. Agency certification marks on the product are proof of certification. Typical product certifications include:

- **In Europe**

The CE marking signifies compliance with all applicable European requirements. If the chassis and other components are not properly CE marked, a supplier's Declaration of Conformity statement to the European EMC directive and Low Voltage directive (as applicable), should be obtained. Additionally, other directives, such as the Radio and Telecommunications Terminal Equipment (R&TTE) directive may also apply depending on product features.

- **In the United States**

A certification mark by a Nationally Recognized Testing Laboratory (NRTL) such as UL, CSA, or ETL signifies compliance with safety requirements. Wiring and cables must also be UL listed or recognized and suitable for the intended use. The FCC Class B logo for home or office use signifies compliance with electromagnetic interference (EMI) requirements.

- **In Canada**

A nationally recognized certification mark such as CSA or cUL signifies compliance with safety requirements. The Industry Canada statement at the front of this product guide demonstrates compliance with Canadian EMC regulations.

